

# **VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)**

Accredited by NAAC with 'A++' Grade  
Ibrahimbagh, Hyderabad-31  
Approved by A.I.C.T.E., New Delhi and  
Affiliated to Osmania University, Hyderabad-07

**Sponsored  
by  
VASAVI ACADEMY OF EDUCATION  
Hyderabad**



## **SCHEME OF INSTRUCTION AND SYLLABI UNDER CBCS FOR M.E. (ECE)**

### **EMBEDDED SYSTEMS AND VLSI DESIGN (ES&VLSID)**

#### **I TO IV SEMESTERS**

**With effect from 2024-25**

**(For the batch admitted in 2024-25)**

**(R-24)**



**DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING**

**Phones: +91-40-23146040, 23146041**

**Fax: +91-40-23146090**

**Institute Vision**

Striving for a symbiosis of technological excellence and human values

**Institute Mission**

To arm young brains with competitive technology and nurture holistic development of the individuals for a better tomorrow

**Department Vision**

Striving for excellence in teaching, training and research in the areas of Electronics and Communication Engineering

**Department Mission**

To inculcate a spirit of scientific temper and analytical thinking, and train the students in contemporary technologies in Electronics & Communication Engineering to meet the needs of the industry and society with ethical values.

**Program Educational Objectives (PEO)**

PG – M.E (ES & VLSID) : Embedded Systems and VLSI Design

- PEO1:** Graduates will be able to design, analyse, and implement systems employing latest techniques and modern tools in the field of Embedded Systems and VLSI Design.
- PEO2:** Graduates will be able to carry out research independently, write and present a substantial research report.
- PEO3:** Graduates will be able to demonstrate effective communication skills and leadership qualities with ethical attitudes in broad societal context while working in a multi-disciplinary environment.

**Program Outcomes (PO)**

PG – M.E (ES & VLSID) : Embedded Systems and VLSI Design :  
Graduates will have

- PO1:** An ability to independently carry out research and development work to offer effective engineering solutions and evaluate system level performance.
- PO2:** An ability to write and present substantial technical reports.
- PO3:** An ability to demonstrate in depth knowledge for analysing and solving problems in the area of Embedded Systems and VLSI Design.
- PO4:** An ability to apply appropriate techniques and modern EDA tools to design and conduct advanced experiments and pursue investigations on circuits and system level design.
- PO5:** An ability to apply engineering and management principles as a member and leader in a team, to manage projects in multi-disciplinary environment with lifelong learning capabilities.

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 31.

### DEPARTMENT OF ECE

### SCHEME OF INSTRUCTION AND EXAMINATION (R - 24)

M.E - Embedded Systems and VLSI Design (ES&VLSID) FIRST SEMESTER (2024-2025)

M.E - ECE (ES&VLSID) I-Semester								
Course Code	Name of the Course	Scheme of Instruction			Scheme of Examination			Credits
		Hours per Week			Duration in Hrs	Maximum Marks		
		L	T	P		SEE	CIE	
THEORY								
P24PC110EC	Professional Core-I: Advanced Embedded System Design	3	-	-	3	60	40	3
P24PC120EC	Professional Core-II: Analog and Digital VLSI Design	3	-	-	3	60	40	3
P24PE1XXEC	Professional Elective-I	3	-	-	3	60	40	3
P24PE1XXEC	Professional Elective-II	3	-	-	3	60	40	3
P24PC140ME	Research Methodology and IPR	2	-	-	3	60	40	2
P24AC110EH	Audit Course-I: English for Research Paper Writing	2	-	-	3	60	40	0
PRACTICALS								
P24PC111EC	Advanced Embedded Systems Laboratory	-	-	4	-	-	50	2
P24PC121EC	Analog and Digital VLSI Design Laboratory	-	-	4	-	-	50	2
TOTAL		16	-	8	-	360	340	18
GRAND TOTAL		24				700		

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 31.

### DEPARTMENT OF ECE

### SCHEME OF INSTRUCTION AND EXAMINATION (R - 24)

M.E Embedded Systems and VLSI Design (ES&VLSID) SECOND SEMESTER (2024-2025)

M.E - ECE (ES&VLSID) II-Semester								
Course Code	Name of the Course	Scheme of Instruction			Scheme of Examination			Credits
		Hours per Week			Duration in Hrs	Maximum Marks		
		L	T	P		SEE	CIE	
THEORY								
P24PC210EC	Professional Core-III: Embedded Real Time Operating Systems	3	-	-	3	60	40	3
P24PC220EC	Professional Core-IV: VLSI Physical Design	3	-	-	3	60	40	3
P24PE2XXEC	Professional Elective-III	3	-	-	3	60	40	3
P24OE2XXXX	Open Elective	3	-	-	3	60	40	3
P24AC210EH	Audit course-II: Pedagogy Studies	2	-	-	3	60	40	0
PRACTICALS								
P24PC211EC	Embedded System Applications Laboratory	-	-	3	-	-	50	2
P24PC221EC	VLSI Physical Design Laboratory	-	-	3	-	-	50	2
P24PW219EC	Mini Project with Seminar	-	-	2	-	-	50	2
TOTAL		14	-	8	-	300	350	18
GRAND TOTAL		22				650		

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 31.

### DEPARTMENT OF ECE

### SCHEME OF INSTRUCTION AND EXAMINATION (R - 24)

M.E Embedded Systems and VLSI Design (ES&VLSID) THIRD SEMESTER (2025-2026)

M.E - ECE (ES&VLSID) III-Semester								
Course Code	Name of the Course	Scheme of Instruction			Scheme of Examination			
		Hours per Week			Duration in Hrs	Maximum Marks		Credits
		L	T	P		SEE	CIE	
THEORY								
P24PE3XXEC	Professional Elective – IV	3	-	-	3	60	40	3
P24PE3XXEC	Professional Elective – V	3	-	-	3	60	40	3
PRACTICALS								
P24PW319EC	Dissertation - Phase-I / Internship	-	-	20	-	-	100	10
TOTAL		6	-	20	-	120	180	16
GRAND TOTAL		26				300		

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 31.

### DEPARTMENT OF ECE

### SCHEME OF INSTRUCTION AND EXAMINATION (R - 24)

M.E Embedded Systems and VLSI Design (ES&VLSID) FOURTH SEMESTER (2025-2026)

M.E - ECE (ES&VLSID) IV-Semester								
Course Code	Name of the Course	Scheme of Instruction			Scheme of Examination			
		Hours per Week			Duration in Hrs	Maximum Marks		Credits
		L	T	P		SEE	CIE	
PRACTICALS								
P24PW419EC	Dissertation – Phase II / Internship	-	-	32	-	Viva – voce (Grade)		16
TOTAL		-	-	32	-	-	-	16
GRAND TOTAL		32						

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 31.

**DEPARTMENT OF ECE**

Semester	Professional Elective	List of Stream Based Professional Electives					
		Professional Elective Stream 1: <b>Embedded Systems</b>		Professional Elective Stream 2: <b>VLSI System Design</b>		Professional Elective Stream 3: <b>Design Verification &amp; Testing</b>	
		Course Code	Title	Course Code	Title	Course Code	Title
<b>I</b>	<b>PE-I</b>	P24PE110EC	Advanced Computer Organization	P24PE120EC	Semiconductor Device Modelling	P24PE130EC	Scripting Languages
	<b>PE-II</b>	P24PE140EC	Programming Languages for Embedded Systems	P24PE150EC	Hardware Descriptive Languages	P24PE160EC	Static Timing Analysis
<b>II</b>	<b>PE-III</b>	P24PE210EC	System on Chip (SoC) Design	P24PE22XEC	VLSI Technology	P24PE230EC	Hardware-Software Co-Design
					FPGA Architectures and Applications		
<b>III</b>	<b>PE-IV</b>	P24PE310EC	High Level Synthesis	P24PE32XEC	Low Power VLSI Design	P24PE330EC	Design Verification using System Verilog
					Software Defined Radio and its Applications		
	<b>PE-V</b>	P24PE340EC	IoT Architectures and Applications	P24PE350EC	Physical Design Automation	P24PE360EC	Design for Testability

<b>Audit courses and Open Electives</b>		
<b>S.No.</b>	<b>Course Code</b>	<b>Course Title</b>
<b>Audit Course – I</b>		
1	P24AC110EH	English for Research Paper Writing
2	P24AC120XX	Value Education
3	P24AC130XX	Stress Management by Yoga
4	P24AC140XX	Sanskrit for Technical Knowledge
<b>Audit Course –II</b>		
1	P24AC210EH	Pedagogy Studies
2	P24AC220XX	Personality Development through Life Enlightenment Skills.
3	P24AC230XX	Constitution of India
4	P24AC240XX	Disaster Management
<b>Open Electives</b>		
1	P24OE210XX	Business Analytics
2	P24OE220XX	Industrial Safety
3	P24OE230XX	Operations Research
4	P24OE240XX	Cost Management of Engineering Projects
5	P24OE250XX	Composite Materials
6	P24OE260XX	Waste to Energy
7	P24OE270XX	Fundamentals of Python Programming



**Syllabus for  
M.E. ECE (ES & VLSI Design)  
I - SEMESTER**

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Advanced Embedded System Design**

Professional Core - I

SYLLABUS FOR M.E. ECE (ES&VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PC110EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<ol style="list-style-type: none"> <li>1. Define and Classify an Embedded System along with design issues.</li> <li>2. Justify the philosophy of ARM core as CPU in SoC designs.</li> <li>3. Demonstrate ARM ISA Assembly usage for data processing.</li> <li>4. Implement different I/O interfacing drivers for Cortex M4 MCU in C.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Define, Classify and Analyze embedded system product design with IC Technology.</li> <li>2. Analyze ARM IP Core usage in design with its programming model and registers.</li> <li>3. Implement ARM assembly construct for Cortex M4</li> <li>4. Design device drivers in embedded-C for Cortex M4 to interface different I/O.</li> <li>5. Propose hardware software codesign issues along with debugging techniques.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	1	2	3	2	-
CO2	1	2	3	2	-
CO3	1	2	3	2	-
CO4	1	2	3	2	-
CO5	1	2	3	2	-

**UNIT – I:**

**Embedded Systems Design Introduction:** Definition of Embedded System; Examples; Classifications based on Cost and Size; Hard Real Time Systems, Soft Real Time Systems, Life Cycle of Embedded System. Issues of Time-to-Market; Selection of CPU, memories and I/O; RISC Vs CISC; Design Metric.

**UNIT – II:**

**Embedded systems using ARM:** Nomenclature; Core Architecture; Introduction to AMBA Bus; Registers – CPSR, SPSR, Modes; Thumb Mode;

Exceptions, OBD using JTAG; ARM family variants: ARM7, ARM9 and Cortex Cores and comparisons.

### UNIT – III:

**ARM CortexM4 architecture and Programming:** Introduction; Cortex CPU Block diagram; ARM Assembly Level Programming: Load and Store instructions; Data Formats and Directives; Addressing Modes; ALU instructions, Branching instructions.

### UNIT – IV:

**ARM [STM32F4xx] Real World Interfacing:** Interfacing of switches, LEDs; Seven Segment Display; Matrix Keypad interface; LCD interfacing; DC Motor, Stepper Motor interfacing designs.

### UNIT – V:

**Hardware Software Codesign:** Co-Design with a case study of Adaptive Cruise Control Design. Software architectures–Round Robin, RR with interrupts, Functional Queue.

Debugging: Host, Target, Big-Endian, Little-Endian ISA. Debugging methods in S/W & H/W.

### Learning Resources:

1. STM32 ARM Programming for Embedded Systems, Muhammad Ali Mazidi, Shujen Chen, Eshragh Ghaemi ISBN: 978-099-792-5944, 2018
2. Muhammad Tahir and Kashif Javed, "ARM® Microprocessor Systems: Cortex®-M Architecture, Programming, and Interfacing", CRC Press, © 2017 by Taylor & Francis Group, LLC
3. NPTEL-"Embedded System Design Using ARM", <https://archive.nptel.ac.in/courses/106/105/106105193/>

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Analog and Digital VLSI Design**

Professional Core - II

SYLLABUS FOR M.E. ECE (ES&VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PC120EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
1. Analyse the effect of sizing the devices of CMOS circuits and its performance in terms of logical and electrical efforts. 2. Introduce the principles of analog circuits and apply the techniques for the design of analog integrated circuit	On completion of the course, students will be able to 1. Design MOS transistor circuits. 2. Know the Physical design flow and different modelling design. 3. Design sequential circuits at higher level. 4. Design analog circuits like single stage and differential amplifiers. 5. Analyze frequency response of active circuits.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	2		1		
CO2	1		1		
CO3	2		3		
CO4	2		3		
CO5	2		2		

**UNIT – I:**

Review: Basic MOS structure and its static behavior, Quality metrics of a digital design: Cost, Functionality, Robustness, Power, Delay, Wire delay models. Physical design flow: Floor planning, Placement, Routing, CTS, Power analysis and IR drop estimation-static and dynamic, ESD protection-human body model.

**UNIT – II:**

Inverter: Static CMOS inverter, Switching threshold and noise margin concepts and their evaluation, Dynamic behavior, Power consumption. Combinational logic: Static CMOS design, Logic effort, Ratioed logic, Pass transistor logic, Dynamic logic, Speed and power dissipation in dynamic logic, Cascading dynamic gates, transmission gate logic.

**UNIT – III:**

Sequential logic: Static latches and registers, Bi-stability principle, MUX based latches, Static SR flip-flops, Master-slave edge-triggered register, Dynamic latches and registers, Concept of pipelining, Pulse registers, and Non-bistable sequential circuit.

Giga-scale dilemma, Short channel effects, High-k, Metal Gate Technology, FinFET, and TFET.

**UNIT – IV:**

Single Stage Amplifier: CS stage with resistance load, Diode connected load, Current source load, Triode load, CS stage with source degeneration, Source follower, Common gate stage, Cascode stage, Choice of device models. Differential Amplifiers: Basic differential pair, Common mode response, Differential pair with MOS loads, Gilbert cell.

**UNIT – V:**

Current mirrors: Basic current mirrors, Applications of current Sources, Sizing issues, Cascode mirrors, Active current mirrors.

**Learning References:**

1. J P Rabaey, A P Chandrakasan, B Nikolic, "Digital Integrated circuits: A design perspective", Prentice Hall electronics and VLSI series, 2nd Edition.
2. Baker, Li, Boyce, "CMOS Circuit Design, Layout, and Simulation", Wiley, 2<sup>nd</sup> Edition.
3. Behzad Razavi, "Design of Analog CMOS Integrated Circuits", TMH, 2007.
4. Phillip E. Allen and Douglas R. Holberg, "CMOS Analog Circuit Design", Oxford, 3rd Edition.
5. Kang, S. and Leblebici, Y., "CMOS Digital Integrated Circuits, Analysis and Design", TMH, 3rd Edition.
6. Pucknell, D.A. and Eshraghian, K., "Basic VLSI Design", PHI, 3rd Edition.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |                                  |                                    |                                   |
|--------------------------|----------------------------------|------------------------------------|-----------------------------------|
| 1. No. of Internal Tests | : <input type="text" value="2"/> | Max. Marks for each Internal Tests | : <input type="text" value="30"/> |
| 2. No. of Assignments    | : <input type="text" value="3"/> | Max. Marks for each Assignment     | : <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Advanced Computer Organization**

Professional Elective - I

SYLLABUS FOR M.E. ECE (ES&VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE110EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
Advanced computing / processing system includes several functional aspects like processing, memory, high speed logic, industry standard interfaces and so on. The major objective of this course is to combine all these functional aspects and develop a processing system for the given specifications.	On completion of the course, students will be able to 1. Evaluate the performance parameters of advanced processors, analyse and compare advantages, limitations and applications of advanced processors. 2. Design the data path and control unit for the given specifications and analyze different control unit design approaches. 3. Demonstrate the knowledge on issues involved in memory organization. 4. Analyze various input-output techniques for proper transfer of data between CPU and different peripheral devices. 5. Become acquainted with recent advancements in the area of advanced processing systems. 6. Use modern EDA tools for solving advanced processing system related problems.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	1		3		
CO2	1		3		
CO3	1		3		
CO4	1		3		
CO5	1	3	2	3	
CO6	2	2	2		2

**UNIT – I**

Basic concepts in processor architecture, Processor Design Techniques: Instruction Pipelining, Super Scalar techniques, Super scalar and super pipeline design, Basic performance issues in pipelining, Pipeline hazards, Reducing pipeline branch penalties.

**UNIT – II**

Control Unit Design approaches, Hardwired Control Unit Design approach, Micro-programmed Control Unit Design Approach, Processor Selection Criteria, Case studies on Micro Blaze Processor, Discrete FPGA-Processor.

**UNIT – III**

Memory Organization: the memory Hierarchy, SDRAM and DDR memories, Cache memory, Elements of cache design, Virtual memory- protection and examples of virtual memory, Replacement Policies.

**UNIT – IV**

I-O Organization: Accessing I/O Devices, Programmed I-O, Interrupts, DMA, Synchronous bus and asynchronous bus, IO Processor, General Purpose Input/Output, Communications Interfaces, Programmable Logic Interfaces, AXI Standard, AXI Interconnects and Interfaces, Processing System External Interfaces.

**UNIT – V**

Parallel Computer Systems: Instruction Level Parallelism (ILP), Multi-processors – Characteristics, Symmetric and Distributive Shared Memory Architecture, Vector Processors, SIMD computers and Super computers, High Performance Computing (HPC), Case study on advanced processing system, An Overview of HPC Applications.

**Learning Resources:**

1. William Stallings, Computer Organization and Architecture designing for Performance, 7<sup>th</sup> edition, PHI, 2007.
2. Carl Hamacher, Vranesic, Zaky, Computer Organization, 5<sup>th</sup> edition, MGH.
3. Hayes John P; Computer Architecture and organization; 3<sup>rd</sup> Edition, MGH, 1998.
4. John L. Hennessy and David A. Patterson, Computer Architecture – A quantitative Approach, 3<sup>rd</sup> Edition, Elsevier, 2005.
5. Computer Architecture and Parallel Processing - Kai Hwang, Faye A.Brigs., MC Graw Hill.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Semiconductor Device Modelling**

Professional Elective - I

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE120EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
To familiarize the students with various two and three terminal electronic devices working and use in the design of real time electronic products.	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Apply the qualitative understanding of semiconductor device physics to develop quantitative device models related to the field of electronics.</li> <li>2. Model the semiconductor homo junctions and characterize the p-n junction diodes.</li> <li>3. Analyze the metal-semiconductor junctions and model the Metal oxide semiconductor junctions.</li> <li>4. Interpret and Model the Metal oxide semiconductor field effect transistors.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	2		2		
CO2	3		3		
CO3	2		2		
CO4	3		3		
CO5	2		2		

**UNIT - I :**

Band diagram of silicon, intrinsic and extrinsic carrier concentration, relation between applied voltage and Fermi level, Carrier statistics; Generation-recombination, SRH theory, diffusion length, carrier life time, Continuity equation, Poisson's equation and solution, Boltzmann transport equation, Mobility and diffusivity; variation of mobility with temperature, doping, high field mobility, low field mobility, Hall mobility/Hall experiment, sheet resistance, drift and diffusion.



**UNIT - II :**

PN junction diode: band diagrams, electrostatics of a PN junction diode, CV characteristics, IV characteristics, high level injection, low level injection, ac characteristics: admittance of a diode, break down phenomenon in diodes; MS contact, band diagrams, ohmic and non ohmic contacts, thermionic Emission model for current transport and current-voltage (I-V) characteristics.

**UNIT – III :**

Ideal MOS structure, MOS device in thermal equilibrium, Non-Ideal MOS: work function differences, charges in oxide, band diagram of non-ideal MOS, flat-band voltage, electrostatics of a MOS, calculating various charges across the MOS Capacitor, threshold voltage.

**UNIT - IV :**

MOSFET as a capacitor (2 terminal device), Three terminal MOSFET, effect on threshold voltage. Drain conductance and transconductance, effect of source bias and body bias on threshold voltage and device operation, Four terminal MOSFET.

**UNIT - V :**

SOI concept, PD SOI, FD SOI and their characteristics, Multi-gate SOI MOSFETs, FinFETs. Tunnel FETs; Nanowire, Gate all around FET, Carbon Nanotube-FETs; Organic FETs.

**Learning Resources:**

1. Donald A Neamen, Semiconductor Physics and Devices: Basic Principles, McGraw-Hill (1997) ISBN 0-256-24214-3.
2. Yannis Tsividis, Operation and Modeling of the MOS transistor, Oxford University Press.
3. Nandita Das Gupta, Amitava Das Gupta, Semiconductor Devices Modeling and Technology, Prentice Hall India.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |                                  |                                    |                                   |
|--------------------------|----------------------------------|------------------------------------|-----------------------------------|
| 1. No. of Internal Tests | : <input type="text" value="2"/> | Max. Marks for each Internal Tests | : <input type="text" value="30"/> |
| 2. No. of Assignments    | : <input type="text" value="3"/> | Max. Marks for each Assignment     | : <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Scripting Languages**

Professional Elective - I

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE130EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
1. To understand control structures of perl. 2. To classify character classes. 3. To apply subroutines and data structures. 4. To acquire the knowledge extending perl. 5. To understand broad features of SKILL, CGI.	On completion of the course, students will be able to 1. Design control structures of perl. 2. Apply subroutines and data structures. 3. Extend perl to embedding perl. 4. Classify character classes. 5. Model features of SKILL, CGI.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2		1
CO2			2		1
CO3			2		1
CO4			2		1
CO5			2		

**UNIT – I**

Overview of scripting languages-PERL, file handles, operators, control structures, regular expressions, built in data types, operators, statements and declarations- simple, compound, loop statements, global and scoped declarations.

**UNIT – II**

Pattern matching - regular expression, pattern matching operators, character classes, positions, capturing and clustering.

**UNIT – III**

Subroutines- syntax, semantics, proto types, format variables, references, data structures- arrays of arrays, hashes of arrays, hashes of functions. Inter process communication,- signals, files, pipes, sockets,.

**UNIT – IV**

Threads- process model, thread model, Perl debugger- using debugger commands, customization, internals and externals, internal data types, extending Perl, embedding Perl, exercises for programming using Perl.

**UNIT – V**

Other languages: Broad features of other scripting languages SKILL, CGI, java script, VB script.

**Learning Resources:**

1. Larry Wall, Tom Christiansen, John Orwant, "programming perl", oreilly publications, 3<sup>rd</sup> edition.
2. Randal L, Schwartz Tom Phoenix, "Learning PERL", Oreilly publications.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |                                |                                    |   |                                 |
|--------------------------|---|--------------------------------|------------------------------------|---|---------------------------------|
| 1. No. of Internal Tests | : | <input type="text" value="2"/> | Max. Marks for each Internal Tests | : | <input type="text" value="30"/> |
| 2. No. of Assignments    | : | <input type="text" value="3"/> | Max. Marks for each Assignment     | : | <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : | <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : | <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Programming Languages for Embedded Systems**

Professional Elective - II

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE140EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<ol style="list-style-type: none"> <li>1. To impart knowledge on embedded C</li> <li>2. To understand algorithms in C++.</li> <li>3. To Develops CPP programming.</li> <li>4. To understand Inheritance and overloading</li> <li>5. To acquire the knowledge about templates concepts.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Write an embedded C application of moderate complexity.</li> <li>2. Develop and analyze algorithms in C++.</li> <li>3. Design embedded software using object oriented programming principles.</li> <li>4. Apply the concept of generic programming for embedded systems.</li> <li>5. Write exception handlers for embedded software.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			3	2	
CO2			3	3	
CO3			2	3	
CO4			2	2	
CO5			3	2	

**UNIT – I**

## Embedded 'C' Programming

- Bitwise operations, Dynamic memory allocation, OS services
- Linked stack and queue, Sparse matrices, Binary tree
- Interrupt handling in C, Code optimization issues
- Writing LCD drives, LED drivers, Drivers for serial port communication
- Embedded Software Development Cycle and Methods (Waterfall, Agile)

**UNIT – II**

Object Oriented Programming - Introduction to procedural, modular, object-oriented and generic programming techniques, Limitations of procedural

programming, objects, classes, data members, methods, data encapsulation, data abstraction and information hiding, inheritance, polymorphism

### **UNIT – III**

CPP Programming: 'cin', 'cout', formatting and I/O manipulators, new and delete operators, Defining a class, data members and methods, 'this' pointer, constructors, destructors, friend function, dynamic memory allocation

### **UNIT - IV**

Overloading and Inheritance: Need of operator overloading, overloading the assignment, overloading using friends, type conversions, single inheritance, base and derived classes, friend classes, types of inheritance, hybrid inheritance, multiple inheritance, virtual base class, polymorphism, virtual functions,

### **UNIT – V**

Templates: Function template and class template, member function templates and template arguments, Exception Handling: syntax for exception handling code: try-catch- throw, Multiple Exceptions.

### **Learning Resources:**

1. Michael J. Pont , "Embedded C", Pearson Education, 2nd Edition, 2008
2. Randal L. Schwartz, "Learning Perl", O'Reilly Publications, 6th Edition 2011
3. A. Michael Berman, "Data structures via C++", Oxford University Press, 2002
4. Robert Sedgewick, "Algorithms in C++", Addison Wesley Publishing Company, 1999
5. Abraham Silberschatz, Peter B, Greg Gagne, "Operating System Concepts", John Willey & Sons, 2005

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |                                |                                    |   |                                 |
|--------------------------|---|--------------------------------|------------------------------------|---|---------------------------------|
| 1. No. of Internal Tests | : | <input type="text" value="2"/> | Max. Marks for each Internal Tests | : | <input type="text" value="30"/> |
| 2. No. of Assignments    | : | <input type="text" value="3"/> | Max. Marks for each Assignment     | : | <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : | <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : | <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Hardware Descriptive Languages**

Professional Elective - II

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE150EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

Course Objectives	Course Outcomes
To impart knowledge on Hardware descriptive Languages	On completion of the course, students will be able to <ol style="list-style-type: none"> <li>1. Differentiate sequential and concurrent codes.</li> <li>2. Design combinational logic circuits using HDL.</li> <li>3. Design sequential logic circuits using HDL.</li> <li>4. Model Analog circuits using Verilog AMS.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2	2	1
CO2			2	2	1
CO3			2	2	1
CO4			2	2	1

**UNIT - I**

Introduction: About VHDL, Design Flows & EDA Tools, Code Structure, Data types, Operators and Attributes: Operators, Attributes, User-Defined Attributes, Operator overloading

**UNIT - II**

Concurrent Code: Concurrent versus Sequential, Using Operators, WHEN, Generate and Block, Sequential Code: Process, Signals and Variables, IF, WAIT, CASE, Using Sequential, Code To Design Combinational Circuits

**UNIT - III**

State Machines: Introduction, Design Style #1, Design Style #2 (Stored Output), Encoding Style: From Binary to One Hot

**UNIT - IV**

Introduction to Verilog-AMS: Verilog Family of Languages, Mixed Signal Simulators,

**UNIT - V**

Applications of Verilog-AMS, Analog Modeling. Language Reference: Basics, Data Types, Signals, Expressions, Analog Behavior

**Learning Resources:**

1. Volnei A. Pedroni, Circuit Design and Simulation with VHDL, 2nd Edition, MIT Press, 2010.
2. Kenneth S Kundert, Olaf Zinke, Designers Guide to Verilog AMS, Springer, 2004

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |                                |                                    |   |                                 |
|--------------------------|---|--------------------------------|------------------------------------|---|---------------------------------|
| 1. No. of Internal Tests | : | <input type="text" value="2"/> | Max. Marks for each Internal Tests | : | <input type="text" value="30"/> |
| 2. No. of Assignments    | : | <input type="text" value="3"/> | Max. Marks for each Assignment     | : | <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : | <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : | <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Static Timing Analysis**

Professional Elective - II

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - I SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE160EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
Students will 1 understand clock domains and critical paths in a given logic design 2 Interpret extracted parasitics and reduce parasitics in critical paths 3 Estimate the Interconnect delays and calculate multiple path slacks 4 Perform cross-talk and Noise analysis in a given net 5 Perform timing analysis and verification across multicycle paths and clock domains	On completion of the course, students will be able to 1. Identify critical paths and estimate propagation delays and skews in a given data-path (PO1 and PO2) 2. Compare the performance of Elmore delay model and higher order interconnect delay models (PO3) 3. Analyse Cross-talk Noise and its reduction in a given data path (PO2) 4. Perform timing analysis across multicycle paths and interpret the results (PO2, PO5) 5. Estimate the timing across multiple clock domains and refine the timing by path balancing (PO2, PO3 and PO5)

**UNIT – I:**

**STA Concepts :** CMOS Logic Design, Basic MOS Structure, CMOS Logic Gate, Standard Cells, Modeling of CMOS Cells, Switching Waveform, Propagation Delay, Slew of a Waveform, Skew between Signals, Timing Arcs and Unateness, Min and Max Timing Paths, Clock Domains, Operating Conditions.

**UNIT – II:**

**Interconnect Parasitics:** RLC for Interconnect, T-model, Pi-model, Wireload Models, Interconnect Trees, Specifying Wireload Models, Representation of Extracted Parasitics, Detailed Standard Parasitic Format, Reduced Standard Parasitic Format, Standard Parasitic Exchange Format, Representing Coupling Capacitances, Hierarchical Methodology, Block Replicated in Layout, Reducing Parasitics for Critical Nets, Reducing Interconnect Resistance, Increasing Wire Spacing, Parasitics for Correlated Nets.

**UNIT – III:**

**Delay Calculations:** Delay Calculation Basics, Delay Calculation with Interconnect, Pre-layout Timing, Post-layout Timing, Cell Delay using Effective Capacitance, Interconnect Delay, Elmore Delay, Higher Order Interconnect Delay Estimation, Full Chip Delay Calculation, Slew Merging , Different Slew Thresholds, Different Voltage



Domains, Path Delay Calculation , Combinational Path Delay, Path to a Flip-flop, Input to Flip-flop Path, Flip-flop to Flip-flop Path, Multiple Paths Slack Calculation.

#### **UNIT – IV:**

Crosstalk and Noise Analysis: Crosstalk Glitch Analysis, Basics Types of Glitches, Rise and Fall Glitches, Overshoot and Undershoot Glitches, Glitch Thresholds and Propagation, DC Thresholds, AC Thresholds, Noise Accumulation with Multiple Aggressors, Aggressor Timing Correlation, Aggressor Functional Correlation, Crosstalk Delay Analysis, Basics, Positive and Negative Crosstalk, Accumulation with Multiple Aggressors, Aggressor Victim Timing Correlation, Aggressor Victim Functional Correlation, Timing Verification Using Crosstalk Delay, Setup Analysis, Hold Analysis, Computational Complexity, Hierarchical Design and Analysis, Filtering of Coupling Capacitances, Noise Avoidance Techniques.

#### **UNIT – V:**

**STA Environment & Timing Verification :** What is the STA Environment, timing issues, Generated Clocks, Example of Master Clock at Clock Gating Cell Output, Constraining Output Paths, Timing Path Groups, Modeling of External Attributes, Modeling Drive Strengths, Modeling Capacitive Load, Design Rule Checks, Virtual Clocks, Refining the Timing Analysis, Multicycle Paths, Crossing Clock Domains, False Paths, Half-Cycle Paths, Removal Timing Check, Recovery Timing Check, Timing across Clock Domains, Examples, Half-cycle Path - Case 1, Half-cycle Path - Case 2, Fast to Slow Clock Domain, Slow to Fast Clock Domain, Multiple Clocks.

#### **Learning Resources:**

1. J. Bhasker, Rakesh Chadha "Static Timing Analysis for Nanometer Designs A Practical Approach" springer, 2009.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF MECHANICAL ENGINEERING

**Research Methodology and IPR**

SYLLABUS FOR M.E. - I SEMESTER

L:T:P (Hrs./week) : 2:0:0	SEE Marks : 60	Course Code: <b>P24PC140ME</b>
Credits : 2	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<p>The objectives of this course are to:</p> <ol style="list-style-type: none"> <li>1. Learn the research methodology and formulation.</li> <li>2. Know the sources of literature, method for collection of research data and report writing.</li> <li>3. Understand IPR laws and Acts.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Explain objectives of research and research process.</li> <li>2. Search the relevant literature and summarize information for formulating the research problem.</li> <li>3. Collect and organize the data for the preparation of research report.</li> <li>4. Explain different types of intellectual property rights and related laws.</li> <li>5. Understand the patent administration system.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	2	2	1		1
CO2	2	2	1		1
CO3	2	2	1		1
CO4	2	2	1		1
CO5	2	2	1		1

**UNIT - I**

**Research Methodology:** Meaning of research, Objectives and motivation of research, types of research, research approaches, significance of research, research methods versus methodology, criteria of good research, Research problem formulation.

**UNIT - II**

**Literature survey:** Importance of literature survey, sources of information, Literature review: Need of Literature review, Plagiarism, research ethics, errors in research, Assessment of quality of journals.

**UNIT - III**

**Data collection & report preparation:** Collection of primary data, secondary data, data organization, methods of data grouping, diagrammatic

representation of data, graphic representation of data. Effective technical writing and how to write report, format of a research proposal, contents of a standard technical journal/conference paper, contents of dissertation.

#### **UNIT - IV**

**Introduction to Intellectual property law:** Basics and types of intellectual property, international organizations, agencies and treaties.

**Law of Trademarks:** Purpose and functions of trademarks, types of Marks, acquisition of trade mark rights, protectable matter and trade mark registration process, Trade Mark Act.

#### **UNIT - V**

**Law of copyrights:** Introduction, common law rights. Rights of reproduction, rights to display work publicly, other limitations of exclusive rights, copyright ownership issues, copy right registration and Berne convention.

**Law of Patents:** Administration of Indian patent system, Introduction, rights under patent law. Design patents, Plant patents. Patenting process. Patent ownership and transfer, new developments in IPR and international patent laws, Geographical Indications.

#### **Learning References:**

1. Stuart Melville and Wayne Goddard, "Research methodology: an introduction for science & engineering students".
2. C. R. Kothari-Research Methodology Methods and Techniques, Second revised edition, New Age International (P) limited Publishers, New Delhi.2013.
3. Ranjitkumar, Research methodology, A step-by-step Guide for Beginners, second Edition, Sage Publications India Pvt. Ltd, New Delhi.2017.
4. Panneer Selvam, Research Methodology, Second Edition, PHI Learning Pvt. Ltd, New Delhi.
5. Deborah E. Bouchoux -Intellectual Property, the law of trademarks, Copyrights, Patents and Trade Secrets. Fourth Edition, CENGAGE Learning India private Limited, New Delhi.2013.
6. P. Narayana, Intellectual property law, Third Edition, Eastern Law House, New Delhi.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF HUMANITIES AND SOCIAL SCIENCES

**English for Research Paper Writing**

Audit Course - I

SYLLABUS FOR M.E. - I SEMESTER

L:T:P (Hrs./week) : 2:0:0	SEE Marks : 60	Course Code: <b>P24AC110EH</b>
Credits : -	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<b>Students should be able to:</b> <ol style="list-style-type: none"> <li>1. understand, how to improve writing skills and level of readability.</li> <li>2. learn about what to write in each section.</li> <li>3. understand the skills needed when writing a Title Ensure the good quality of paper at very first-time submission</li> </ol>	<b>Students will be able to</b> <ol style="list-style-type: none"> <li>1. write research papers.</li> <li>2. write citations as per the MLA style sheet and APA format.</li> <li>3. write concisely and clearly following the rules of simple grammar, diction and coherence.</li> </ol>

**UNIT-I:**

Planning and Preparation, Word Order, Breaking up long sentences. Structuring Paragraphs and Sentences, Being concise and Removing Redundancy, Avoiding Ambiguity and Vagueness

**UNIT-II:**

Clarifying Who Did What, Highlighting your Findings, Hedging and Criticizing, Paraphrasing and Plagiarism, Sections of a Paper, Abstracts, Introduction

**UNIT-III:**

Review of the Literature, Methods, Results, Discussion, Conclusions, The Final Check.

**UNIT-IV:**

Key skills are needed when writing a Title, key skills are needed when writing an Abstract, key skills are needed when writing an Introduction, skills needed when writing a Review of the Literature, useful phrases, how to ensure paper is as good as it could possibly be the first-time submission.

**UNIT-V:**

Skills are needed when writing the Methods, skills needed when writing the Results, skills are needed when writing the Discussion, skills are needed when writing the Conclusions.

### **Learning Resources :**

1. Goldbort R (2006) Writing for Science, Yale University Press (available on Google Books).
2. Day R (2006) How to Write and Publish a Scientific Paper, Cambridge University Press.
3. Highman N (1998), Handbook of Writing for the Mathematical Sciences, SIAM Highman's book.
4. Adrian Wallwork, English for Writing Research Papers, Springer New York Dordrecht Heidelberg London, 2011

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Advanced Embedded Systems Laboratory**

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - I SEMESTER

L:T:P (Hrs./week) : 0:0:4	SEE Marks : -	Course Code: <b>P24PC111EC</b>
Credits : 2	CIE Marks : 50	Duration of SEE : -

COURSE OBJECTIVES	COURSE OUTCOMES
1. Design Embedded Systems by using ARM Cortex M4x based MCU as the CPU. 2. Implement real world interfacing with ARM and design prototypes.	On completion of the course, students will be able to 1. Program ARM based microcontroller using its assembly constructs. 2. Implement C constructs to design ARM based embedded system. 3. Interface real world input and output devices to ARM 4. Design and execute a mini project for the given specifications. 5. Propose different debugging methods for implementing embedded systems.

**CO-PO Mapping**

	PO1	PO2	PO3	PO4	PO5
CO1	1	2	3	2	-
CO2	1	2	3	2	-
CO3	1	2	3	2	-
CO4	1	2	3	2	-
CO5	1	2	3	2	-

**List of Experiments using Embedded C/Embedded C++:****Module – 1 (ARM Cortex M4 Assembly Language Programming)**

1. ARM Data formats and Directives.
2. Addressing Modes.
3. Arithmetic & Logical instructions
4. Looping and Branching Instructions
5. Conditional Subroutines
6. ARM Conditional Execution in Assembly

**Module-2 (STM32F4xxx MCU based SBC)**

7. GPIO Programming
8. Interfacing 7-segment display.
9. Interfacing a 4x4 Matrix keyboard for input and 2x16 LCD for output.
10. Developing user interface for ARM.
11. Timer Programming
12. Full duplex UART Driver design in Embedded C.

**Suggested tools for used:**

1. Hardware Target CPU; STM32F4xx (ARM CortexM4F from ST.
2. Embedded Compiler – Keil  $\mu$ Vision5 IDE: ARM compiler
3. Embedded Debugger – Keil  $\mu$ Vision5 Debugger
4. Hardware Simulator – Proteus 8.x

The break-up of CIE :

- |   |   |    |
|---|---|----|
| 1. No. of Internal Test                           | : | 1  |
| 2. Max. Marks for each internal tests             | : | 12 |
| 3. Marks for assessment for day to day evaluation | : | 18 |

Duration of Internal Test: 3 Hours

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Analog and Digital VLSI Design Laboratory**

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - I SEMESTER

L:T:P (Hrs./week) : 0:0:4	SEE Marks : -	Course Code: <b>P24PC121EC</b>
Credits : 2	CIE Marks : 50	Duration of SEE : -

COURSE OBJECTIVES	COURSE OUTCOMES
1. To demonstrate computer aided design tools for the modeling, design, analysis and verification of digital and analog integrated circuits.	On completion of the course, students will be able to 1. Develop HDL code for combinational and sequential logic circuits and Synthesize them. 2. Verify the designs using system Verilog. 3. Design and simulate analog circuits.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	3	-	3	3	-
CO2	3	-	3	3	-
CO3	3	-	3	3	-

**Part A**

- Design and simulate Adder /Counter using Verilog HDL.
- ASIC Synthesis of Adder/ Counter and find its performance parameters.
- Design and Simulate a traffic signal controller using finite state machine.
- Verify functionality of adder with test bench using System Verilog.
- Verify functionality of Counter with test bench using System Verilog.
- Insert clock gating for power optimization in Counter.

Note: Above experiments are to be carried out using Cadence tools (incisive simulator and genus)

**PART B**

- Design and Simulation of Symmetrical CMOS inverter and evaluate its performance.
- Design and simulate a 6-T SRAM cell and find its parameters.
- Design and simulation of current mirror and plot its behavior.



10. Simulate a single stage MOS amplifier with two different loads and compare their performance.
11. Design and Simulate a differential amplifier with active load.
12. Design and simulate a general purpose CMOS OPAMP.

Note: Above experiments are to be carried out using Cadence tools (virtuoso Schematic composer and spectre circuit simulator)

Note: Minimum of ten experiments are to be conducted.

The break-up of CIE :

- |   |   |    |
|---|---|----|
| 1. No. of Internal Test                           | : | 1  |
| 2. Max. Marks for each internal tests             | : | 12 |
| 3. Marks for assessment for day to day evaluation | : | 18 |

Duration of Internal Test : 3 Hours

**Syllabus for  
M.E. ECE (ES & VLSI Design)  
II - SEMESTER**

VASAVI COLLEGE OF ENGINEERING (Autonomous)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Embedded Real Time Operating Systems**

Professional Core - III

SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PC210EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

<b>COURSE OBJECTIVES</b>	<b>COURSE OUTCOMES</b>
To develop an Embedded system applications using techniques of Scheduling and interface with appropriate device drivers.	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Differentiate OS, RTOS and classify Real-Time kernels.</li> <li>2. Demonstrate the use of different scheduling algorithms to estimate the deadline and propose different inter-task-communication models opted in RTOS.</li> <li>3. Describe Linux kernel architecture and process management.</li> <li>4. Differentiate Linux user space processes and kernel space threads and implement device drivers using Shell APIs.</li> <li>5. Suggest fault tolerance methods for real time systems.</li> </ol>

**CO-PO Mapping**

<b>CO</b>	<b>PO1</b>	<b>PO2</b>	<b>PO3</b>	<b>PO4</b>	<b>PO5</b>
CO1	3	3	2		
CO2	2	2	1		
CO3	2	2	1		
CO4	3	2	2	1	1
CO5	1	1	2	1	1

**UNIT-I**

Concept of Embedded Operating Systems, Differences between Traditional OS and RTOS; Architecture of RTOS, Kernels – classifications, importance of scheduler in OS: objectives and functions; Hard versus Soft Real-time systems – examples, Jobs & Processes, timing constraints. Pre-emptive Vs Non-pre-emptive kernels.

**UNIT-II**

Task Priorities, Scheduling, inter task Communication & Synchronization – Definition of Context Switching, Foreground ISRs and Background Tasks. Critical Section: Re-entrant Functions, Inter Process Communication (IPC) – IPC through Semaphores, Mutex, Mailboxes, Message Queues or Pipes and Event Flags.

Scheduling Algorithms – RMS, Preemptive EDF scheduling – principle, comparisons.

### **UNIT-III**

Linux Kernel 2.x architecture – File system, Concepts of Process – creation, Process Control Block (PCB); process Vs thread; Concurrent Execution. Process Management in Linux–forks Vs Vfork; process state transitions, zombie state, Memory Management Algorithms.

### **UNIT-IV**

Device Drivers & Communication with Hardware – Definition; advantages of Modules; kernel space Vs user space; Concurrency and Race Conditions; classification of device drivers – character drivers, block drivers and net drivers, Interrupt handling in RTOS, Debugging Techniques.

### **UNIT-V**

Fault-Tolerance Techniques & RTOS Application Domains: What causes failures, Fault types, Fault detection, Hardware and software Redundancy. Case studies of RTOS-RT: RTOS for Image Processing – Embedded RTOS for voice over IP – RTOS for fault Tolerant Applications – RTOS for Control Systems.

### **Learning Resources:**

1. Jean J. Labrosse, "Embedded Systems Building Blocks: Complete and Ready-to-Use Modules in C", CMP Publishers Jan 1999.
2. Robert Love, "Linux Kernel Development" (3<sup>rd</sup> Edition), Novell Press 2010.
3. Jane W.S. Liu, Real Time Systems, Pearson Education, Asia, 2001.
4. Jonathan Corbet, Alessandro Rubini, Greg Kroah-Hartman, "Linux Device Drivers", 3<sup>rd</sup> Edition, O'Reilly Media Publishers
5. Real Time Systems, C.M. Krishna and G. Shin, McGraw-Hill Companies Inc., McGraw Hill International Editions, 1997.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (Autonomous)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**VLSI Physical Design**

Professional Core - IV

SYLLABUS FOR M.E. ECE (ES&VLSID) - II SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PC220EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
1. To understand the structures of different components of VLSI design. 2. To draw stick and layout diagrams of circuits. 3. To acquire the knowledge of cell based designs.	On completion of the course, students will be able to 1. Design the structures of different components of VLSI design. 2. Apply the basic concepts of physical design to layouts and stick diagrams. 3. Apply Design rules for layouts of circuits. 4. Design hierarchical circuit Layouts using cell concepts. 5. Analyze the basic algorithms which are involved in the process of physical design automation.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1				2	
CO2				2	
CO3			1	3	
CO4				3	
CO5	1			2	

**UNIT – I**

VLSI Design cycles and new trends in Design cycles, physical design cycles and new trends in physical design cycles, Components of VLSI, Various layers of VLSI, Typical structures of BJTS, MOSFETS, Resistors, capacitors, inductors ,Brief review of technology , cost and performance analysis.(Reference 1)

**UNIT – II**

Basic concepts of Physical Design - layout of basic structures – wells, FET, BJT, resistors, capacitors, contacts, vias and wires (Interconnects), physical design of logic gates – NOT, NAND and NOR. Mask overlays for different structures. Parasitics – latch up and its prevention. Device matching and common centroid techniques for analog circuits(Reference 1 and 3)

**UNIT – III**

Design rules – fabrication errors, alignment sequence and alignment inaccuracies, process variations and process deltas, drawn and actual dimensions and their effect on design rules– scalable design rules. Scalable

CMOS (SCMOS) design rules, layout design, and stick diagrams, Hierarchical stick diagrams. (Reference 4)

#### **UNIT – IV**

Cell concepts – cell based layout design – Wein-berger image array — design hierarchies. System level physical design- large scale physical design , interconnect delay modeling, cross talk, floor planning, routing and clock distribution. (Reference 1 and 3)

#### **UNIT – V**

Factors, Complexity Issues and NP-hard Problems, Basic Algorithms (Graph and Computational Geometry): Basic terminology, graph search algorithms, spanning tree algorithms, shortest path algorithms, matching algorithms, min-cut and max-cut algorithms, Steiner tree algorithms. (Referene 1 and 2)

#### **Learning Resources:**

1. Algorithms for VLSI Physical Design automation, Naveed Sherwani. 3<sup>rd</sup> edition Kluwer academic publishers
2. Algorithms for VLSI Design automation, Sabith H. Gerez, John Wiley & sons, Inc.
3. John P. Uyemura, Introduction to VLSI Circuits and Systems, John Wiley & sons, Inc.
4. Modern VLSI Design (System on Chip), Wayne Wolf, Pearson Education, 2002.
5. R. Jacob Baker; Harry W. Li., David E. Boyce, CMOS Circuit Design, Layout and Simulation, IEEE Press, Prentice Hall of India.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |                                  |                                    |                                   |
|--------------------------|----------------------------------|------------------------------------|-----------------------------------|
| 1. No. of Internal Tests | : <input type="text" value="2"/> | Max. Marks for each Internal Tests | : <input type="text" value="30"/> |
| 2. No. of Assignments    | : <input type="text" value="3"/> | Max. Marks for each Assignment     | : <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**System on Chip (SoC) Design**

Professional Elective - III

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE210EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<p>This course covers the advanced design and analysis of digital circuits with HDL. The primary goal is to provide in depth understanding of system design. The course enables students to apply their knowledge for the design of advanced digital hardware systems with help of FPGA tools.</p> <ol style="list-style-type: none"> <li>1. Understand the FPGA hardware architecture and interconnect technologies.</li> <li>2. Apply the knowledge for the design of digital hardware systems.</li> <li>3. Implementation of FPGA implementation methodologies with the help of FPGA tools.</li> <li>4. Block level design verification by writing the test benches.</li> <li>5. System level design verification by writing the test cases.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Understand design flow of SoC</li> <li>2. Implement the basic level logic functions in hardware system.</li> <li>3. Implement the block level and system level IP cores.</li> <li>4. Writing test benches for block level design verification.</li> <li>5. Writing test benches for system level design verification.</li> </ol>

**UNIT - I**

Introduction to SoC Design, constituents of SoC, Application areas of SoC, SoC development life cycle FPGA architectures for implementing SoC design, FPGA based SoC design flow.

**UNIT - II**

Front End Design and Back-End Design Overview, Programmable system on chip design, Design with Xilinx zynq SoC platform, Implementation examples of logic functions using LUTs and CLBs, Finite state machine design examples.

**UNIT - III**

Introduction to IP cores, Block level design using IP cores, Implementation of Block RAM using IP cores, FIFO design and implementation using IP cores.

**UNIT - IV**

Block Level Design Verification: Introduction to Block-level verification, verification approaches, Functional verification, Static timing verification, Front End Design stages in detail-Flow: Architecture, Design Entry, Simulation, Synthesis and Verification, 16 bit ALU design verification with VIO hardware debugger, Constraints and timings analysis.

**UNIT - V**

System Level Design Verification: Introduction to system level verification, creating system-level test benches, Applying and migrating test bench-SoC, Design challenges and approaches.

**Learning Resources:**

1. Veena S. Chakravarthi, "A practical Approach to VLSI System on Chip (SoC) Design", A comprehensive Guide, Springer.
2. Prakash Rashinkar, Peter Paterson and Leena Singh "System-on-a-Chip Verification – Methodology and Techniques", Kluwer Academic Publishers.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |                                  |                                    |                                   |
|--------------------------|----------------------------------|------------------------------------|-----------------------------------|
| 1. No. of Internal Tests | : <input type="text" value="2"/> | Max. Marks for each Internal Tests | : <input type="text" value="30"/> |
| 2. No. of Assignments    | : <input type="text" value="3"/> | Max. Marks for each Assignment     | : <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes



## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**VLSI Technology**

Professional Elective - III

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE22XEC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<ol style="list-style-type: none"> <li>1. Impart a knowledge about VLSI Integrated circuits their structures, evolution and benefits of these circuits in realizing complex electronics functions to students.</li> <li>2. Impart knowledge about IC fabrication technologies and their advancement over time.</li> <li>3. Impart knowledge about the sub process technologies that are involved in IC fabrication and how they are put together to form complete fabrication process.</li> <li>4. Acquaint the students about clean room environments needed for IC fabrication and their importance.</li> <li>5. Impart knowledge about complex process of VLSI packaging and testing and their advancements.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Describe evolution and progress of VLSI technology, Electronic functions and basic device structures on Integrated circuits.</li> <li>2. Apply alternate technologies and Process flows for realization of VLSI chips</li> <li>3. Demonstrate Unit processes involved in VLSI technology such as silicon wafer preparation, epitaxy, oxidation and diffusion, lithography, etching, implantation etc.</li> <li>4. Specify Other unit processes involved in VLSI technology such as deposition, lithography and etching</li> <li>5. Specify Clean Room environments needed for VLSI processing and packaging and testing of the VLSI chips.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2		1
CO2			2		1
CO3			2		1
CO4			2		1
CO5			2		1

**UNIT – I**

Introduction – Integrated Circuits Review of history of VLSI technology progress–. Electronic Functions – Components – Differences between - Analog and Digital ICs. Basic Devices in ICs – Structures Resistors – Capacitors – Inductors. Diodes – Bipolar Junction Transistors – Field Effect Transistors. Isolation techniques in MOS and bipolar technologies.

**UNIT – II**

Monolithic ICs – Silicon as the Base Material and its advantages, various Layers of ICs – Substrate – Active Layer -Oxide/Nitride Layers – Metal/Poly Silicon Layers – Functions of Each of the Layers. Description of Process Flow for Typical Devices viz., FET and BJT.

**UNIT – III**

Silicon Wafer Preparation – Electronic Grade Silicon – CZ and FZ Methods of Single Crystal Growth – Silicon Shaping – Mechanical Operations, Chemical Operations – Prefabrication Processes.

Epitaxy: Growth Dynamics – Process Steps. Vapour phase, Solid phase and Molecular Beam Epitaxial Processes.

Oxide Growth: Structure of  $\text{SiO}_2$ , – Oxide Growth by Thermal method.

**UNIT – IV**

Deposition techniques Chemical Vapour Deposition (CVD) and associated methods like LPCVD and PECVD. PVD thermal evaporation and sputtering. Step coverage issues.

Lithography: Steps involved in Photolithography – Quality of the Pattern – photo resists and their characteristics, steppers, X-ray – Electron Beam Lithography.

Etching: Chemical, Electro Chemical – Plasma (Dry Etching) Reactive Plasma Etching.

**UNIT – V**

Ion implantation: Range and Penetration Depth – Damage and Annealing.

Diffusion: Constant and Infinite Source Diffusions – Diffusion Profiles – Multiple Diffusions and Junction Formations. Packaging: Bonding and Packaging, Testing. Clean rooms and their importance in VLSI technology

**Learning Resources:**

1. S.M. Sze, VLSI Technology, Mc Grawhill International Editions.
2. CY Chang and S.M. Sze, VLSI Technology, Tata Mc Graw-Hill Companies Inc.
3. J.D. Plummer, M.D. Deal and P.B. Griffin, The Silicon VLSI Technology Fundamentals, Practice and modeling, Pearson Education 2009
4. Stephen A, The Science and Engineering of Microelectronic Fabrication, Campbell Oxford 2001.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |  |                                    |   |   |
|--------------------------|---|--|------------------------------------|---|---|
| 1. No. of Internal Tests | : | <div style="border: 1px solid black; padding: 2px 10px;">2</div> | Max. Marks for each Internal Tests | : | <div style="border: 1px solid black; padding: 2px 10px;">30</div> |
| 2. No. of Assignments    | : | <div style="border: 1px solid black; padding: 2px 10px;">3</div> | Max. Marks for each Assignment     | : | <div style="border: 1px solid black; padding: 2px 10px;">5</div>  |
| 3. No. of Quizzes        | : | <div style="border: 1px solid black; padding: 2px 10px;">3</div> | Max. Marks for each Quiz Test      | : | <div style="border: 1px solid black; padding: 2px 10px;">5</div>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**FPGA Architectures and Applications**

Professional Elective - III

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE22XEC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<ol style="list-style-type: none"> <li>1. To provide knowledge on the fundamental concepts, architectures, programming methods and applications of Programmable Logic Devices (PLDs).</li> <li>2. To understand the design methodologies and programming techniques for implementing logic function, digital circuit and systems using modern tools.</li> <li>3. To analyze and compare the performance characteristics, architectures, advantages, limitations and applications of FPGAs.</li> <li>4. To understand the concepts of finite state machines and applications.</li> <li>5. Performance parameters of FPGAs in the system design.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Demonstrate the fundamental concepts and applications of different Simple Programmable Logic Devices (SPLDs).</li> <li>2. Apply the knowledge and concepts to design and implement logic functions with SPLDs.</li> <li>3. Understand the concepts, programming methods and applications of FPGAs for designing digital circuits.</li> <li>4. Design and implementation of sequential circuits using finite state machines.</li> <li>5. Design and implement FPGA based digital circuits and systems for different applications using industry standard design tools.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	2		3	2	
CO2	2		3	2	
CO3	2		3	2	
CO4	2		3	2	
CO5	3		3	3	

**UNIT - I:**

**Programmable Logic Devices (PLDs):** Introduction to Simple Programmable Logic Devices (SPLDs), Programmable Read Only Memory (PROM), Programmable Logic Array (PLA), Programmable Array Logic (PAL), Comparison of PLDs, Programming methods for PLDs, Applications of PLDs.

**UNIT - II:**

**Realization of Logic Functions using SPLDs:** Concept of logic synthesis, Shanon's expansion / decomposition theorem, Principles of operation of PROMs, Design procedure with PROMs, Logic function implementation with PROMs, Principles of operation of PLA, Design procedure with PLA, Logic

function implementation with PLA, Principles of operation of PAL, Design procedure with PAL, Logic function realization with PAL.

### UNIT - III:

**Field Programmable Gate Arrays (FPGAs):** Architecture and Basic building blocks and resource blocks of FPGAs, Configurable Logic Blocks (CLBs), IO Block, Programming methods, Anti fuse, SRAM and EPROM based FPGAs, Implementation examples of logic function using LUTs and CLBs. Maximum frequency calculation, Set up & Hold time.

### UNIT - IV:

**Finite State Machines:** Realization of sequential circuits, State diagram, state table, state assignment, choice of flipflops, Timing diagram, One hot encoding, Mealy and Moore state machines, State minimization. FSM based Applications.

### UNIT - V:

**System Design:** FPGA Design flow, Clock skew, Jitter, Propagation delay, FSM approaches, Realization of shift registers and counters, Introduction to IP Cores, FIFO Design using IP cores, Implementation of Block RAM (BRAM).

### Learning Resources:

1. P.K. Chan & S. Mourad, Digital Design Using Field Programmable Gate Array, Pearson Education 2009.
2. Wayne Wolf, FPGA based System Design, Pearson Education 2009.
3. Steve Kilts, Advanced FPGA Design: Architecture, Implementation and optimization, A Jhon Wiley & Sons, Inc., publication.
4. Pong P Chu, "FPGA Proto Typing by Verilog Examples" WILEY Publications.
5. S. Trimberger, Edr., Field Programmable Gate Array Technology, Kluwer Academic Publications, 1994.
6. J. Old Field, R. Dorf, Field Programmable Gate Arrays, John Wiley & Sons, Newyork, 1995.
7. Data sheets and Manuals from Xilinx, Altera, AMD, Actel.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Hardware-Software Co-design**

Professional Elective - III

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE230EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
To understand architectures, co-design methodology and design	On completion of the course, students will be able to <ol style="list-style-type: none"> <li>1. Identify the need for co-design</li> <li>2. Model data flow and implement the same through software and hardware</li> <li>3. Construct data flow and control flow graphs</li> <li>4. Design data flow model for a FSM</li> <li>5. Design an SoC for given application</li> </ol>

**UNIT –I**

Co- Design Issues: Co- Design Models, Architectures, Languages, A Generic Co-design Methodology. Co- Synthesis Algorithms: Hardware software synthesis algorithms: hardware – software partitioning distributed system co-synthesis.

**UNIT –II**

Prototyping and Emulation: Prototyping and emulation techniques, prototyping and emulation environments, future developments in emulation and prototyping architecture specialization techniques, system communication infrastructure.

Target Architectures: Architecture Specialization techniques, System Communication infrastructure, Target Architecture and Application System classes, Architecture for control dominated systems (8051-Architectures for High performance control), Architecture for Data dominated systems (ADSP21060, TMS320C60), Mixed Systems.

**UNIT –III**

Compilation Techniques and Tools for Embedded Processor Architectures: Modern embedded architectures, embedded software development needs,

compilation technologies, practical consideration in a compiler development environment.

#### **UNIT –IV**

Design Specification and Verification: Design, co-design, the co-design computational model, concurrency coordinating concurrent computations, interfacing components, design verification, implementation verification, verification tools, interface verification

#### **UNIT –V**

Languages for System – Level Specification and Design-I: System – level specification, design representation for system level synthesis, system level specification languages, Languages for System – Level Specification and Design-II: Heterogeneous specifications and multi language co-simulation, the cosyma system and lycos system.

#### **Learning Resources:**

1. Hardware / Software Co- Design Principles and Practice – Jorgen Staunstrup, Wayne Wolf –2009, Springer.
2. Hardware / Software Co- Design - Giovanni De Micheli, Mariagiovanna Sami, 2002, Kluwer Academic Publishers.
3. A Practical Introduction to Hardware/Software Co-design -Patrick R. Schaumont - 2010 – Springer

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |                                  |                                    |                                   |
|--------------------------|----------------------------------|------------------------------------|-----------------------------------|
| 1. No. of Internal Tests | : <input type="text" value="2"/> | Max. Marks for each Internal Tests | : <input type="text" value="30"/> |
| 2. No. of Assignments    | : <input type="text" value="3"/> | Max. Marks for each Assignment     | : <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEAPRTMENT OF HUMANITIES AND SOCIAL SCIENCES

**Pedagogy Studies**

Audit Course - II

## SYLLABUS FOR M.E. - II SEMESTER

L:T:P(Hrs./week): 2:0:0	SEE Marks : 60	Course Code: <b>P24AC210EH</b>
Credits : -	CIE Marks : 40	Duration of SEE : 3 Hours

<b>COURSE OBJECTIVES</b>	<b>COURSE OUTCOMES</b>
<p>This course will enable the students to:</p> <ol style="list-style-type: none"> <li>1. Review existing evidence on the review topic to inform programme design and policy making undertaken by the DfID, other agencies and researchers.</li> <li>2. Identify critical evidence gaps to guide the development.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. What pedagogical practices are being used by teachers in formal and informal classrooms in developing countries?</li> <li>2. What is the evidence on the effectiveness of these pedagogical practices, in what conditions, and with what population of learners?</li> <li>3. How can teacher education (curriculum and practicum) and the school curriculum and guidance materials best support effective pedagogy?</li> </ol>

<b>Unit</b>	<b>Content</b>
1a.	<p><b>Introduction and Methodology :</b></p> <ul style="list-style-type: none"> <li>➤ Theories of learning, Curriculum, Teacher education.</li> <li>➤ Conceptual framework, Research questions.</li> <li>➤ Overview of methodology and Searching.</li> <li>➤ Pedagogic theory and pedagogical approaches.</li> <li>➤ Teachers' attitudes and beliefs and Pedagogic strategies.</li> </ul>
b.	<p><b>Thematic overview:</b></p> <ul style="list-style-type: none"> <li>➤ Pedagogical practices that are being used by teachers.</li> <li>➤ Curriculum, Teacher education.</li> </ul> <p>How can teacher education (curriculum and practicum) and the curriculum and guidance materials best support effective pedagogy.</p>

2	<ul style="list-style-type: none"> <li>• <b>Research gaps and future directions</b> <ul style="list-style-type: none"> <li>➤ Research design- Lesson plans, Course plans</li> <li>➤ Teacher education</li> <li>➤ Curriculum and assessment</li> </ul> </li> </ul>
---	---

### Learning Resources:

1. Ackers J, Hardman F (2001) Classroom interaction in Kenyan primary schools, Compare, 31 (2):245-261.
2. Agrawal M (2004) Curricular reform in schools: The importance of evaluation, Journal of Curriculum Studies, 36 (3): 361-379.
3. Akyeamong K (2003) Teacher training in Ghana - does it count? Multi-site teacher education research project (MUSTER) country report 1. London: DFID.
4. Akyeamong K, Lussier K, Pryor J, Westbrook J (2013) Improving teaching and learning of basic maths and reading in Africa: Does teacher preparation count? International Journal Educational Development, 33 (3): 272–282.
5. Alexander RJ (2001) Culture and pedagogy: International comparisons in primary education. Oxford and Boston: Blackwell.
6. Chavan M (2003) Read India: A mass scale, rapid, 'learning to read' campaign.
7. [www.pratham.org/images/resource%20working%20paper%202.pdf](http://www.pratham.org/images/resource%20working%20paper%202.pdf).

The break-up of CIE : Internal Tests + Assignments + Quizzes

1. No. of Internal Tests :  Max. Marks for each Internal Tests :
2. No. of Assignments :  Max. Marks for each Assignment :
3. No. of Quizzes :  Max. Marks for each Quiz Test :

Duration of Internal Test: 90 Minutes



## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Embedded System Applications Laboratory**

SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P(Hrs./week): 0:0:3	SEE Marks : -	Course Code: <b>P24PC211EC</b>
Credits : 2	CIE Marks : 50	Duration of SEE : -

Course Objectives	Course Outcomes
Acquire skills to handle ARM powered cross compilers and Validate different RTOS scheduling algorithms in embOS RTOS and linux.	On completion of the course, students will be able to 1. Design Embedded Systems with C51 target interfacing sensor and transducer for RT applications. 2. Design and implement off-chip memories for embedded systems. 3. Demonstrate host to ARM target communication in embOS RTOS environment. 4. Configure emPower board with embOS and validate different scheduling algorithms. 5. Demonstrate different IPC schemes for multi-tasking in embOS and Linux OS.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	2	2	2	3	1
CO2	3	1	2	3	1
CO3	3	3	3	3	2
CO4	3	3	3	3	2
CO5	3	3	3	3	2

**List of Experiments in RTOS using Embedded – C/C++:****S.No****Experiment**

1. Interfacing a sensor with ADC0804.
2. Multi-sensor interfacing with ADC0808.
3. Transducer interfacing with DAC0808 for generating a triangular, sawtooth sinusoidal waveforms.

4.      Interfacing & controlling the DC Moter
5.      Interfacing & controlling the stepper motor
6.      Off-chip EEPROM 2KB/4KB interfacing for storing & retrieving lookup tables.
7.      Emboss Real time task creation, Demonstration of Multitasking
8.      SRAM interface design (1KB/4KB)
9.      Interfacing with DS1307 RTC.
10.     Round Robin Scheduling of 2 Tasks in RTOS
11.     Preemptive Scheduling of 2 Tasks in RTOS
12.     Preemptive Round Robin Scheduling of 3 Tasks
13.     IPC between 2 Tasks with Binary Semaphore
14.     Mailbox usage for IPC between 2 tasks in RTOS

#### **New / Additional experiments planned:**

1. Design a Round Robin with the interrupt driven scheduling in ARM by creating three tasks such that 2 tasks perform IPC with the same priority.
2. Implementation RTOS scheduling of 3 tasks that has to wait for message Queue in Cortex M4F embOS for UI design.

#### **Suggested tools for use:**

1. Hardware Target CPU                      - Cortex M4F power Segger Board, AT89S52
2. Embedded Software Development - Embedded Studio V3.12a
3. Embedded Debugger                      - Cortex M4F ARM Jlink
4. RTOS   - emboss

The break-up of CIE :

- |   |   |    |
|---|---|----|
| 1. No. of Internal Test                           | : | 1  |
| 2. Max. Marks for each internal tests             | : | 12 |
| 3. Marks for assessment for day to day evaluation | : | 18 |

Duration of Internal Test : 3 Hours

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**VLSI Physical Design Laboratory**

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P(Hrs./week): 0:0:3	SEE Marks : -	Course Code: <b>P24PC221EC</b>
Credits : 2	CIE Marks : 50	Duration of SEE : -

COURSE OBJECTIVES	COURSE OUTCOMES
To Design and simulate basic building blocks of mixed signal IC's and perform full custom design of cells.	On completion of the course, students will be able to 1. Perform floor planning, placement and routing of Adder/Counter. 2. Perform layout and parasitic extraction of Adder/Counter. 3. perform full custom design of basic gates and differential amplifier.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	3	-	3	3	-
CO2	3	-	3	3	-
CO3	3	-	3	3	-

**Part A**

1. Layout of basic gates. (inverter / Nand / NOR, Full custom design).
2. DRC and LVS of basic gates. (inverter / Nand / NOR, Full custom design).
3. Parasitic extraction and Post layout simulation of basic gates. (inverter / Nand / NOR, Full custom design).
4. Floor planning, placement and routing of Adder.
5. Layout and parasitic extraction of Adder.
6. Static timing analysis and power analysis of Adder.
7. Floor planning, placement and routing of Counter.
8. Layout and parasitic extraction of Counter.
9. Static timing analysis and power analysis of Counter.
10. Layout of Differential Amplifier.

11. Parasitic extraction and post Layout simulation of Differential Amplifier.
12. Layout, Parasitic extraction and post layout simulation of 1 bit comparator.

Note: Above experiments are to be carried out using Cadence tools (virtuoso Layout editor, assura, spectre circuit simulator and innovus)

Note: Minimum of ten experiments are to be conducted.

The break-up of CIE :

- |   |   |               |
|---|---|---------------|
| 1. No. of Internal Test                           | : | <div>1</div>  |
| 2. Max. Marks for each internal tests             | : | <div>20</div> |
| 3. Marks for assessment for day to day evaluation | : | <div>30</div> |

Duration of Internal Test : 3 Hours

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Mini Project with Seminar**

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - II SEMESTER

L:T:P (Hrs./week) : 0:0:2	SEE Marks : -	Course Code: <b>P24PW219EC</b>
Credits : 2	CIE Marks : 50	Duration of SEE : -

COURSE OBJECTIVES	COURSE OUTCOMES
Prepare the student for a systematic and independent study of the state of the art topics in a broad area of his / her specialization.	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Selection of a suitable mini project topic / problem for investigation and presentation.</li> <li>2. Carryout literature survey and prepare the presentation.</li> <li>3. Formulating the problem, identify tools and techniques for solving the problems.</li> <li>4. Clear communication and presentation of the seminar topic.</li> <li>5. Apply ethical principles in preparation of seminar report.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1	1	2	1	1	1
CO2	1	2	1	1	1
CO3	1	2	1	1	1
CO4	1	2	1	1	1
CO5	1	2	1	1	1

Oral presentation and technical report writing are two important aspect of engineering education. The objective of the Mini Project and seminar is to prepare the student for a systematic and independent study of the state of the art topics in the advanced fields of Embedded Systems, VLSI Design and related topics.

Mini Project topics may be chosen by the students with advice from the faculty members. Students are to be exposed to the following aspects for a seminar presentation.

- Literature survey
- Organization of the material
- Presentation of OHP slides / LCD presentation
- Technical writing

Each student required to:

1. Submit a one page synopsis before the seminar talk for display on the notice board.
2. Give a 20 minutes time for presentation following by a 10 minutes discussion.
3. Submit a detailed technical report on the seminar topic with list of references and slides used.

Seminars are to be scheduled from the 3<sup>rd</sup> week to the last week of the semester and any change in schedule shall not be entertained.

For award of sessional marks, students are to be judged by at least two faculty members on the basis of an oral and technical report preparation as well as their involvement in the discussions.

**Syllabus for  
M.E. ECE (ES & VLSI Design)  
III - SEMESTER**

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**High Level Synthesis**

Professional Elective - IV

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - III SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24PE310EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

Course Objectives	Course Outcomes
To expose the students, the basics of FPGA designs and synthesis.	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Develop simple arithmetic modules and implement in FPGA .(PO1, PO5)</li> <li>2. Understand various libraries used in HLS based design (PO2)</li> <li>3. Apply various coding styles for FPGA synthesis and compare their performance (PO1, PO2)</li> <li>4. Compare the precision data types in System C and Vivado HLS (PO2, PO3)</li> <li>5. Synthesize a subsystem design using Vivado HLS and port it in FPGA (PO3, PO5)</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2		1
CO2			2		1
CO3			2		1
CO4			2		1
CO5			2		1

**UNIT – I**

Introduction to C-based FPGA Design, Using Vivado HLS HLS UltraFast Design Methodology Managing Interfaces Design Optimization RTL Verification, Exporting the RTL Design

**UNIT – II**

Introduction to the Vivado HLS C Libraries, Arbitrary Precision Data Types Library, The HLS Stream Library, HLS Math Library, Vivado HLS Video Library, The HLS IP Libraries, HLS Linear Algebra Library.



**UNIT – III**

Coding Styles: Unsupported C Constructs, The C Test Bench Functions, Loops, Arrays, Data Types. C++ Classes and Templates, Using Assertions, SystemC Synthesis.

**UNIT – IV**

Command Reference, Graphical User Interface (GUI) Reference, Send Feedback, Interface Synthesis Reference, AXI4 Slave Lite C Driver Reference, Video Functions Reference.

**UNIT – V**

HLS Linear Algebra Library, C Arbitrary Precision Types, C++ Arbitrary Precision Types, C++ Arbitrary Precision Fixed Point Types, Comparison of SystemC and Vivado HLS Types.

**Learning Resources:**

2. Andres Takach, Creating C++ IP for High Performance Hardware Implementations of FFTs. DesignsDesignCon2002.
3. Preston A. Jackson, Cy P. Chan, Jonathan E. Scalera, Charles M. Rader, and M. Michael Vai - A Systolic FFT Architecture for Real Time FPGA Systems. MIT Lincoln Laboratory 244 Wood ST, Lexington, MA 02420
4. Vivado Design Suite User Guide and Vivado Design Suite Tutorial for High-Level Synthesis.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |                                |                                    |   |                                 |
|--------------------------|---|--------------------------------|------------------------------------|---|---------------------------------|
| 1. No. of Internal Tests | : | <input type="text" value="2"/> | Max. Marks for each Internal Tests | : | <input type="text" value="30"/> |
| 2. No. of Assignments    | : | <input type="text" value="3"/> | Max. Marks for each Assignment     | : | <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : | <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : | <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Low Power VLSI Design**

Professional Elective - IV

SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - III SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24PE32XEC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<ol style="list-style-type: none"> <li>1. Study different abstraction levels in VLSI Design and the impact of power reduction methods at higher levels</li> <li>2. Apply leakage control mechanisms to reduce static power consumption in DSM VLSI regime</li> <li>3. Apply technology independent and technology-dependent techniques for Dynamic power reduction in CMOS circuits</li> <li>4. Study and apply various software power estimation and optimization techniques for low power VLSI system design</li> <li>5. Apply low power circuit and architectural techniques for reducing power consumption in SRAM designs</li> </ol>	<ol style="list-style-type: none"> <li>1. On completion of the course, students will be able to Distinguish the impact of various power reduction techniques at different levels of VLSI Design</li> <li>2. Identify the sources of power dissipation and apply leakage control techniques to reduce static power consumption in CMOS circuits</li> <li>3. Apply technology independent and technology-dependent techniques for Dynamic power reduction in CMOS circuits</li> <li>4. Analyze different power reduction techniques for VLSI systems at Design time, Run-time and Stand-by modes</li> <li>5. Employ software power estimation and optimization methods for low power VLSI system design</li> <li>6. Apply low power circuit and architectural techniques such as capacitance reduction, gated clocking, VDD and V<sub>th</sub> scaling, DVS etc in digital systems and SRAM designs</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2		1
CO2			2		1
CO3			2		1
CO4			2		1
CO5			2		1

**UNIT – I**

Introduction to Low Power design: Why worry about power – at global and SOC levels, Emerging zero-power applications (WSN), 20 nm scenario, Design-productivity challenge, Impact of implementation choices, Motivation for LPD, Basic VLSI Design Flow, Optimization examples at various levels (System, Sub-system, RTL, Gate, Circuit and Device levels)

Sources of power dissipation, MOS transistor leakage components, Static Power dissipation, Active Power dissipation, Circuit Techniques for Low Power Design – Standby leakage control using transistor stacks, Multiple V<sub>TH</sub> and dynamic V<sub>TH</sub> techniques, Supply voltage scaling technique (Ref-1)

**UNIT – II**

Power Optimization Techniques – I: Dynamic Power Reduction Approaches, Circuit Parallelization, Voltage Scaling Based Circuit Techniques, Circuit Technology – Independent Power Reduction, Circuit Technology Dependent Power Reduction; Leakage Power Reduction – Leakage Components, Design Time Reduction Techniques, Run-time Stand-by Reduction Techniques, Run-time Active Reduction Techniques Reduction in Cache Memories (Ref-2)

**UNIT – III**

Power Optimization Techniques – II: Energy Recovery Circuit Design, Adiabatic – Charging Principle and its implementation issues (Ref-2) Software Design for Low Power: Sources of Software Power Dissipation, Software Power Estimation, Software Power Optimizations, Automated Low-Power Code Generation, Co-design for Low Power (Ref-3)

**UNIT - IV**

Low Voltage Low Power Static Random Access memories: Basics, Race between 6T and 4T memory cells, LVLP SRAM Cell designs- Shared bit-line SRAM cell configuration, Power efficient 7T SRAM cell with current mode read and write, Loadless CMOS 4T SRAM cell, The 1T SRAM cell, Pre-charge and Equalization Circuit, Dynamic and static decoders, Voltage Sense amplifier, Output Latch, Low Power SRAM Techniques: Sources of SRAM Power, Low Power Circuit techniques such as capacitance reduction, Leakage current reduction (Ref-1)

**UNIT - V**

Large LP VLSI System design and Applications: Architecture-driven Voltage Scaling, Power optimization using operation reduction and operation substitution, Pre-computation based optimization, Multiple and Dynamic supply voltage design, Choice of supply voltages, Varying the clock speed, varying the  $V_{DD}$  of RAM structures, Gated Clocking. Leakage current reduction in medical devices (Ref-1)

**Learning Resources:**

1. Kiat-Seng Yeo and Kaushik Roy, "Low-Voltage, Low-Power VLSI Subsystems, Tata McGrawhill Edition, 2005. (Units I, IV and V)
2. Christian Pigué, "Low Power CMOS Circuits Technology, Logic Design and CAD Tools", 1<sup>st</sup> Indian Reprint, CRC Press, 2010.(Units II and III)
3. Kaushik Roy and Sharat Prasad, " Low-Power CMOS VLSI Circuit Design" , Wiley Pub., 2000 (Unit III)
4. Dimitrios Soudris, Christian Pigué and Coostas Goutis, "Designing CMOS Circuits for Low Power", Kluwer Academic Pub, 2002 (Topics beyond Syllabus)
5. J. Rabaey, Low Power Design Essentials, 1<sup>st</sup> Edition, Springer Publications, 2010 (for seminars and assignments)

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

**VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)**  
**ACCREDITED BY NAAC WITH 'A++' GRADE**  
**IBRAHIMBAGH, HYDERABAD – 500 031**

**DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING**

**Software Defined Radio and its Applications**

Professional Elective - IV

SYLLABUS FOR M.E. ECE (ES&VLSID) - III SEMESTER

L:T:P (Hrs/Week): 3:0:0	SEE Marks: 60	Course Code: <b>P24PE32XEC</b>
Credits: 3	CIE Marks: 40	Duration of SEE: 3 Hours

<b>COURSE OBJECTIVES</b>	<b>COURSE OUTCOMES</b>
The course aims to provide students with a comprehensive understanding of Software Defined Radio (SDR) principles and technologies, focusing on GNU Radio, RTL-SDR, Pluto SDR, and USRP platforms. Through theoretical instruction and hands-on exercises, students will learn to use GNU Radio for signal processing tasks, explore RTL-SDR for practical applications such as spectrum analysis, delve into Pluto SDR for wireless communication implementations, and master USRP platforms for advanced SDR applications. Additionally, students will explore advanced topics and real-world applications in SDR, engage in collaborative projects, and develop practical skills to design and implement custom SDR solutions, fostering a deep understanding of SDR concepts and proficiency in utilizing SDR technologies.	On completion of the course, students will be able to 1. Analyze GNU Radio for various signal processing, and communication applications. 2. Develop the skills to set up, configure, and operate RTL-SDR devices for practical applications. 3. Implementing signal processing algorithms and communication techniques using Pluto SDR and GNU Radio. 4. Configure and interface with USRP devices using GNU Radio 5. Design and implement custom communication systems, and apply advanced signal processing techniques for SDR applications

**CO-PO-PSO Mapping:**

CO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12	PSO1	PSO2	PSO3
CO1	3	3	2		3									3	3
CO2	3	3	2		3									3	3
CO3	3	3	2		3									3	3
CO4	3	3	2		3									3	3
CO5	3	3	2		3									3	3

**Unit 1: Introduction to GNU Radio**

Introduction to GNU Radio, Role of GNU Radio in SDR applications, Introduction to GNU Radio Toolkit,

GNU Radio Architecture and Components, GNU Radio Companion (GRC): Basics and Workflow

Signal Processing Blocks in GNU Radio, Communication blocks in GNU Radio

### **Unit 2: RTL-SDR**

Software Defined Radio (SDR) concepts: benefits, limitations, block diagrams, Introduction to RTL-SDR hardware, Installation and setup of RTL-SDR software. Basic signal reception using RTL-SDR, Signal Reception Techniques with RTL-SDR, Spectrum Analysis using RTL-SDR

### **UNIT-III: Pluto SDR**

Hardware Overview and Specifications, Setting up Pluto SDR Environment (Drivers, Firmware)

Pluto SDR Applications and Use Cases, Signal Processing with Pluto SDR, Configuring Pluto SDR with GNU Radio

### **UNIT-IV: USRP**

USRP Hardware Overview and Specifications, Installing and Configuring USRP Drivers and Software

Advanced Signal Processing Techniques with USRP, Designing Custom Communication Systems with USRP, Setting up USRP with GNU Radio

### **UNIT-V:**

Advanced Signal Processing Techniques in GNU Radio, Real-world SDR applications and case studies,

Digital Modulation Schemes and Demodulation Techniques, Spectrum Monitoring, Cognitive Radio

Design and Implementation of SDR Application

### **Learning Resources:**

1. Travis F. Collins, Robin Getz, Di Pu, Alexander M. Wyglinski, "Software-Defined Radio for Engineers" Analog Devices perpetual eBook license – Artech House copyrighted material. 2018 ISBN-13: 978-1-63081-457-1
2. Marcus D. Leech. "Software Defined Radio using GNU Radio". CreateSpace Independent Publishing Platform, 2015.
3. GNU Radio Companion: The Software Defined Radio Cookbook by Andreas Jahn, Benjamin M. Klein (2010)
4. Hacking RF: Learn How to Build Software Defined Radios by Nickolas Palazzo (2016)
- 5.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |   |   |                                |                                    |   |                                 |
|---|---|--------------------------------|------------------------------------|---|---------------------------------|
| 1. No. of Internal Tests                  | : | <input type="text" value="2"/> | Max. Marks for each Internal Tests | : | <input type="text" value="30"/> |
| 2. No. of Assignments                     | : | <input type="text" value="3"/> | Max. Marks for each Assignment     | : | <input type="text" value="5"/>  |
| 3. No. of Quizzes                         | : | <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : | <input type="text" value="5"/>  |
| 6. Duration of Internal Tests: 90 Minutes |   |                                |                                    |   |                                 |

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Design and Verification using System Verilog**

Professional Elective - IV

## SYLLABUS FOR M.E. ECE (ES&amp;VLSID) - III SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE330EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
<ol style="list-style-type: none"> <li>Students will build a layered test bench and simulate a simple logic block</li> <li>They will learn the important features of System Verilog</li> <li>They will develop a test bench using object oriented concepts for verifying a digital system</li> <li>They will understand the limitations of Randomization of functions and implement random device configuration</li> <li>They will connect the test bench and design of a given system</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>Identify the need for a test bench and specify the formal verification techniques (PO2)</li> <li>Implement simulation based verification of a given system (PO2)</li> <li>Implement a formal test bench using object oriented concepts for verifying a digital system. (PO3)</li> <li>Model hardware interfaces with concurrency constructs. (PO3)</li> <li>CO5 Investigate the interface between the test bench and the design of a given system using IEEE1800 Verilog assertions.(PO4)</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2	2	1
CO2			2	2	1
CO3			2	2	1
CO4			2	2	1
CO5			2	2	1

**UNIT - I**

**Verification Methodologies:** The Verification Process, The Verification Plan, The Verification Methodology Manual, Basic Testbench Functionality, Directed Testing, Methodology Basics, Constrained-Random Stimulus, What Should You Randomize, Functional Coverage, Testbench Components, Layered Testbench, Building a Layered Testbench, Simulation Environment Phases, Maximum Code Reuse, Testbench Performance, Conclusion.

**UNIT - II**

**Fundamentals of System Verilog :** DATA TYPES, Built-in Data Types, Fixed-Size Arrays, Dynamic Arrays, Queues, Associative Arrays, Linked Lists, Array Methods, Choosing a Storage Type, Creating New Types with typedef, Creating User-Defined Structures, Enumerated Types, Constants, Strings,

Expression Width, Net Types, Conclusion, PROCEDURAL STATEMENTS AND ROUTINES, Introduction Procedural Statements, Tasks, Functions, and Void Functions, Task and Function Overview, Routine Arguments, Returning from a Routine, Local Data Storage, Time Values.

### UNIT - III

**Object Oriented Concepts for verification:** Think of Nouns, not Verbs, Your First Class, Where to Define a Class, OOP Terminology, Creating New Objects, Object Deallocation, Using Objects, Static Variables vs. Global Variables, Class Routines, Defining Routines Outside of the Class, Scoping Rules, Using One Class Inside Another, Understanding Dynamic Objects, Copying Objects, Public vs. Private, Straying Off Course, Building a Testbench.

### UNIT – IV

**RANDOMIZATION Techniques for Verification :** What to Randomize, Randomization in SystemVerilog, Constraint Details, Solution Probabilities, Controlling Multiple Constraint Blocks, Valid Constraints, In-line Constraints, The pre\_randomize and post\_randomize Functions, Constraints Tips and Techniques, Common Randomization Problems, Iterative and Array Constraints, Atomic Stimulus Generation vs. Scenario Generation, Random Control, Random Generators, Random Device Configuration.

### UNIT - V

**CONNECTING THE TESTBENCH AND DESIGN:** Separating the Testbench and Design, The Interface Construct, Stimulus Timing, Interface Driving and Sampling, Connecting It All Together, Top-Level Scope, Program – Module Interactions, SystemVerilog Assertions, The Four-Port ATM Router.

### Learning Resources:

1. CHRIS SPEAR Synopsys, Inc. "SYSTEMVERILOG FOR VERIFICATION A Guide to Learning the Testbench Language Features" Springer.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Tests: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
ACCREDITED BY NAAC WITH 'A++' GRADE  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

## IoT Architectures and Applications

(Professional Elective-V)

### SYLLABUS FOR M.E. III – SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE340EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
The purpose of this course is to impart knowledge on IoT Architecture, practical constraints, various protocols and multiple case studies.	On completion of the course, students will be able to 1. Understand the Architectural Overview of IoT 2. Enumerate the need and the challenges in Real World Design Constraints 3. Choose the required protocol for a given application. 4. Explore IoT usage in various applications 5. Understand the Security requirements in IoT.

#### CO-PO Mapping

CO	PO1	PO2	PO3	PO4	PO5
CO1			3		
CO2			3		
CO3			3		
CO4			3		
CO5			3		

#### UNIT - I : IoT

Definition and Technologies that led to evolution of IOT, Characteristics of IoT, Physical Design of IoT, Logical Design of IoT, IoT Enabling Technologies, IoT Levels & Deployment. M2M and IoT Technology Fundamentals- Devices and gateways, Introduction to cloud IOT platforms like MS Azure, AWS IOT, Google Cloud IOT, Thingworx, Business processes in IoT.

#### UNIT - II : IoT Reference Architecture

Introduction, Functional View, Information View, Deployment and Operational View, Other Relevant architectural views. IoT edge system architecture.

**Real-World Design Constraints:** Technical Design constraints, Connectivity constraints, Data representation and visualization, Big Data Management.

#### UNIT - III : IoT communications

**Data link and physical layer Protocols:** PHY/MAC Layer (IEEE 802.11, IEEE 802.15), Bluetooth Low Energy, Thread, introduction to Wi-SUN.

**Network Layer Protocols:** IPv6, 6LoWPAN;

**Transport layer protocols:** TCP, UDP;

**Messaging protocols:** Quality of services in MQTT, standards and security in MQTT, CoAP, AMQP.



**UNIT - IV : Case Studies**

Smart Cities, Smart Homes, Smart Transportation, Smart Healthcare, Precision Agriculture, Connected Vehicles.

**IOT in Indian Scenario:** i) IOT and Aadhaar ii) IOT for health services. iii) IOT for financial inclusion. iv) IOT for rural empowerment v) India Urban Data Exchange (IUDX).

**Industry 4.0:** Industrial Internet of Things (IIoT), Reference Architecture, Characteristics of Industry 4.0.

**UNIT - V : Securing the Internet of Things**

Security Requirements in IoT Architecture - Security in Enabling Technologies, Security Concerns in IoT Applications.

Security Architecture in the Internet of Things - Security Requirements in IoT, Insufficient Authentication/Authorization, Insecure Access Control, Threats to Access Control, Privacy, and Availability, Attacks Specific to IoT. Security and Vulnerabilities – Secrecy & Secret Key Capacity, Authentication/Authorization for Smart Devices, Transport Encryption, Secure Cloud/Web Interface, Secure Software/Firmware, Physical Layer Security.

**Learning Resources:**

- 1 Pethuru Raj and Anupama C. Raman, —The Internet of Things: Enabling Technologies, Platforms, and Use Cases", 1<sup>st</sup> Edition, 2017, CRC Press.
- 2 David Hanes, Gonzalo Salgueiro, Patrick Grossetete, Rob Barton, Jerome Henny "IoT Fundamentals: Networking technologies Protocols, and Use Cases for the internet of things", June, 2017, Cisco press.
- 3 Jan Holler, VlasiosTsiatsis, Catherine Mulligan, Stefan Avesand, Stamatios Karnouskos, David Boyle, —From Machine-to-Machine to the Internet of Things: Introduction to a New Age of Intelligence||, 1st Edition, 2014, Academic Press.
- 4 Arshdeep Bahga, Vijay Madiseti, —Internet of Things: A Hands-on Approach||, Universities Press, 2014.
- 5 Practical Internet of Things Security (Kindle Edition) by Brian Russell, Drew Van Duren, Packt Publishing, 2016.
- 6 Securing the Internet of Things Elsevier Authors: Shancang Li Li Da Xu, Paperback ISBN: 9780128044582, Imprint: Syngress Published Date: 13th January 2017.
- 7 <https://nptel.ac.in/courses/106105166/5>
- 8 <https://nptel.ac.in/courses/108108098/4>

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |                                   |  |
|--------------------------|---|-----------------------------------|--|
| 1. No. of Internal Tests | : <span style="border: 1px solid black; padding: 2px 5px;">2</span> | Max. Marks for each Internal Test | : <span style="border: 1px solid black; padding: 2px 5px;">30</span> |
| 2. No. of Assignments    | : <span style="border: 1px solid black; padding: 2px 5px;">3</span> | Max. Marks for each Assignment    | : <span style="border: 1px solid black; padding: 2px 5px;">5</span>  |
| 3. No. of Quizzes        | : <span style="border: 1px solid black; padding: 2px 5px;">3</span> | Max. Marks for each Quiz Test     | : <span style="border: 1px solid black; padding: 2px 5px;">5</span>  |

Duration of Internal Tests: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Physical Design Automation**

Professional Elective - V

SYLLABUS FOR M.E. ECE (ES&VLSID) - III SEMESTER

L:T:P (Hrs./week) : 3:0:0	SEE Marks : 60	Course Code: <b>P24PE350EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
Students will develop placement and routing algorithms for VLSI Designs using C / C++.	On completion of the course, students will be able to <ol style="list-style-type: none"> <li>1. understand the relationship between design automation algorithms and various constraints posed by VLSI fabrication and design technology.</li> <li>2. adapt the design algorithms to meet the critical design parameters.</li> <li>3. map various layout optimization techniques to the algorithms.</li> <li>4. develop proto-type EDA tool and test its efficacy.</li> </ol>

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2		1
CO2			2		1
CO3			2		1
CO4			2		1

**UNIT-I** : VLSI design Cycle, Physical Design Cycle, Design Rules, Layout of Basic Devices, and Additional Fabrication, Design styles: full custom, standard cell, gate arrays, field programmable gate arrays, sea of gates and comparison, system packaging styles, multi chip modules. Design rules, layout of basic devices, fabrication process and its impact on physical design, interconnect delay, noise and cross talk, yield and fabrication cost. Factors,

**UNIT-II:** Complexity Issues and NP-hard Problems, Basic Algorithms (Graph and Computational Geometry): graph search algorithms, spanning tree algorithms, shortest path algorithms, matching algorithms, min-cut and max-cut algorithms, Steiner tree algorithms.

**UNIT-III:** Basic Data Structures, atomic operations for layout editors, linked list of blocks, bin based methods, neighbour pointers, corner stitching, multi-layer operations.

**UNIT-IV:** Graph algorithms for physical design: classes of graphs, graphs related to a set of lines, graphs related to set of rectangles, graph problems in physical design, maximum clique and minimum coloring, maximum k-independent set algorithm, algorithms for circle graphs.

**UNIT-V:** Partitioning algorithms: design style specific partitioning problems, group migrated algorithms, simulated annealing and evolution, and Floor planning and pin assignment, Routing and placement algorithms.

### **Learning Resources:**

1. Naveed Shervani, Algorithms for VLSI Physical Design Automation, 3rd Edition, Kluwer Academic, 1999.
2. Charles J Alpert, Dinesh P Mehta, Sachin S Sapatnekar, Handbook of Algorithms for Physical Design Automation, CRC Press, 2008

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Design for Testability**

Professional Elective - V

SYLLABUS FOR M.E. ECE (ES&VLSID) - III SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24PE360EC</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
To expose the students, the basics of testing techniques for circuits.	On completion of the course, students will be able to 1. Illustrate Yield, Fabrication defects, Errors and Faults in VLSI Circuits 2. Simulate digital ICs in the presence of faults and evaluate the given test set for fault coverage. 3. Generate test patterns for detecting single stuck faults in combinational and sequential circuits. 4. Establish a fault model for memory and apply March Tests for fault detection 5. Identify schemes for introducing testability into digital circuits with improved fault coverage. 6. Compare different approaches for introducing BIST into logic circuits, memories and embedded cores.

**CO-PO Mapping**

CO	PO1	PO2	PO3	PO4	PO5
CO1			2		1
CO2			2		1
CO3			2		1
CO4			2		1
CO5			2		1

**UNIT – I**

**Introduction:** Role of Testing, Digital and Analog VLSI Testing, The Rule of TEN, Yield, Defects and Faults, Reliability and Failure Rate, Test and Design for Testability (DFT)

**Modeling:** Modeling digital circuits at logic level, register level and structural models.

**Logic Simulation:** Types of simulation, Delay models, Element evaluation, Hazard detection, Gate level event- driven simulation. {Ref1: Chs 1,2,3 and Ref2: Ch3}

**UNIT – II**

**Fault Modeling** – Logic fault models, Fault detection and redundancy, Fault equivalence, Fault location and Fault Collapsing, The Single Stuck and Multiple

Stuck Fault Models. Bridging Faults, CMOS Technology Considerations, Intermittent Faults

Fault Simulation: Applications, Fault Simulation for Combinational circuits. (Ref1: Chs 4 and 5)

### UNIT – III

**Testing for single stuck faults (SSF):** Automated Test Pattern Generation (ATPG/ATG) for SSFs in Combinational Circuits, Algorithms (D, PODEM, FAN), ATG for SSFs in Sequential Circuits. Functional Testing without and with Specific Fault Models

**Memory Test:** Memory density and Defect trends, Faults, Memory Test levels, March Test Notation, Fault Modeling, Memory Testing {Ref1: Chs 6 and 8, Ref2: Ch 9}

### UNIT – IV

**Design for Testability** – Controllability and Observability, AdHoc DFT techniques. Scan architectures and testing – Generic boundary scan, Full Serial integrated scan, Storage cells for scan design. Board level and system level DFT approaches. Boundary scan standards. Compression techniques – Syndrome test and Signature analysis – LFSR based Signature Analysis (Ref1: Chs 9 and 10)

### UNIT – V

**Built-in Self-Test (BIST)** – BIST Concepts and test pattern generation. Specific BIST Architectures in brief.

**System Test and Core-Based Design:** System Test Problem Defined, Functional Test, Diagnostic Test, Testable System design, Core-Based Design and Test –Wrapper, A Test Architecture for SOC, An Integrated Design and Test Approach. {Ref1: Ch 11, Ref2: Ch 18}

DSP-based Analog and Mixed-Signal Test: Functional DSP-based Testing, Static ADC/DAC Testing Methods, CODEC Testing, Dynamic Flash ADC Testing using FFT Technique. {Ref2: Ch 10}.

### Learning Resources:

1. Miron Abramovici, Melvin A. Breur, Arthur D. Friedman, "Digital Systems Testing and Testable Design", Jaico Publishing House, 2001.
2. Michael L Bushnell and Vishwani D Agrawal, "Essentials of Electronic Testing for Digital, Memory and Mixed Signal VLSI Circuits" Kluwer Academic Publishers, 2002
3. NPTEL Course on VLSI Testing – IIT Kharagpur

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |                                  |                                    |                                   |
|--------------------------|----------------------------------|------------------------------------|-----------------------------------|
| 1. No. of Internal Tests | : <input type="text" value="2"/> | Max. Marks for each Internal Tests | : <input type="text" value="30"/> |
| 2. No. of Assignments    | : <input type="text" value="3"/> | Max. Marks for each Assignment     | : <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

**VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)**  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

**DEAPRTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING**

**Dissertation - Phase - I / Internship**

**SYLLABUS FOR M.E. ECE (ES&VLSID) - III SEMESTER**

L:T:P(Hrs./week): 0:0:20	SEE Marks: -	Course Code: <b>P24PW319EC</b>
Credits : 10	CIE Marks: 100	Duration of SEE : -

<b>COURSE OBJECTIVES</b>	<b>COURSE OUTCOMES</b>
Prepare the student for a systematic and independent study of the state of the art topics in a broad area of his/her specialization	On completion of the course, students will be able to <ol style="list-style-type: none"> <li>1. To select the complex engineering problems beneficial to the society and develop solutions with appropriate considerations in the area of VLSI and embedded systems.</li> <li>2. To apply modern tools and analyze the results to provide valid conclusions.</li> <li>3. To communicate effectively the solutions with report and presentation following ethics</li> <li>4. To adapt for the advanced technological changes</li> <li>5. To work in teams and apply management principles to complete the project economically</li> </ol>

**CO-PO Mapping**

<b>CO</b>	<b>PO1</b>	<b>PO2</b>	<b>PO3</b>	<b>PO4</b>	<b>PO5</b>
CO1	2	2			
CO2				3	
CO3			2		
CO4			2		
CO5					3

The students must be given clear guidelines to execute and complete the project on which they have delivered a seminar in the 3<sup>rd</sup> semester of the course.

All projects will be monitored at least twice in a semester through student's presentation. Sessional marks should be based on the grades/marks, awarded by a monitoring committee of faculty members as also marks given by the supervisor.

Efforts be made that some of the projects are carried out in industries with the help of industry support.

The final project reports must be submitted two weeks before the last working day of the semester.

The project works must be evaluated by departmental committee containing of HOD, two senior faculty and supervisor.

---

### **Continuous Internal Evaluation (CIE) – 100 marks:**

<b>Evaluation Criteria</b>	<b>Maximum Marks</b>
Literature Survey	20
Problem Formulation	20
Design/ Methodology	20
Implementation & Results	20
Presentation & Documentation	20

**Note:** Rubrics are used for assessment and evaluation.

**Syllabus for  
M.E. ECE (ES & VLSI Design)  
IV - Semester**



VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Dissertation - Phase - II / Internship**

SYLLABUS FOR M.E. ECE (ES&VLSID) - IV SEMESTER

L:T:P(Hrs./week):0:0:32	SEE Marks: -	Course Code: <b>P24PW419EC</b>
Credits : 16	CIE Marks: <b>Viva-Voce Grade</b>	Duration of SEE:

<b>COURSE OBJECTIVES</b>	<b>COURSE OUTCOMES</b>
Prepare the student for a systematic and independent study of the state of the art topics in a broad area of his/her specialization	On completion of the course, students will be able to <ol style="list-style-type: none"> <li>1. To select the complex engineering problems beneficial to the society and develop solutions with appropriate considerations in the area of VLSI and embedded systems.</li> <li>2. To apply modern tools and analyze the results to provide valid conclusions.</li> <li>3. To communicate effectively the solutions with report and presentation following ethics</li> <li>4. To adapt for the advanced technological changes</li> <li>5. To work in teams and apply management principles to complete the project economically</li> </ol>

**CO-PO Mapping**

<b>CO</b>	<b>PO1</b>	<b>PO2</b>	<b>PO3</b>	<b>PO4</b>	<b>PO5</b>
CO1	2	2			
CO2				3	
CO3			2		
CO4			2		
CO5					3

The students must be given clear guidelines to execute and complete the project on which they have delivered a seminar in the 3<sup>rd</sup> semester of the course.

All projects will be monitored at least twice in a semester through student's presentation. Sessional marks should be based on the grades/marks, awarded by a monitoring committee of faculty members as also marks given by the supervisor.

Efforts be made that some of the projects are carried out in industries with the help of industry coordinates.

Common norms will be established for documentation of the project report by the respective department.

The final project reports must be submitted two weeks before the last working day of the semester.

The project works must be evaluated by an external examiner and based on his comments a viva voce will be conducted by the departmental committee containing of HOD, two senior faculty and supervisor.

### Criteria for Award of Grades:

Academic Performance (%)	Letter Grade	Grade Points
90 to 100	A+ (Outstanding)	10
80 to < 90	A (Excellent)	09
70 to < 80	B+ (Very Good)	08
60 to < 70	B (Good)	07
50 to < 60	C (Average)	06
< 50	F (Fail)	0

**Note:** Following criteria used for assessment and evaluation.

QUALITY		( )
1.	Review of literature	( )
2.	Scope of the work	( )
3.	Technical soundness (Methodology / Experimental set-up)	( )
4.	Timeliness of work	( )
5.	Conclusions drawn	( )
CONTENT		
6.	Adequacy of data, information and Practical applications / utility	( )
7.	Organization of the thesis	( )
PRESENTATION		
8.	Clear explanation of the work	( )
9.	Justification of work done	( )
10.	Clarity and unambiguity of the language	( )
Total Score out of 100		( )
(in words _____)		

## **Open Electives**

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEAPRTMENT OF HUMANITIES AND SOCIAL SCIENCES

**Business Analytics**

Open Elective

SYLLABUS FOR M.E. - II SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24OE210XX</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

<b>COURSE OBJECTIVES</b>	<b>COURSE OUTCOMES</b>
<ol style="list-style-type: none"> <li>1. Understand the role of business analytics within an organization.</li> <li>2. Analyze data using statistical and data mining techniques and understand relationships between the underlying business processes of an organization.</li> <li>3. To gain an understanding of how managers use business analytics to formulate and solve business problems and to support managerial decision making.</li> <li>4. To become familiar with processes needed to develop, report, and analyze business data.</li> <li>5. Use decision-making tools/Operations research techniques.</li> <li>6. Mange business process using analytical and management tools.</li> <li>7. Analyze and solve problems from different industries such as manufacturing, service, retail, software, banking and finance, sports, pharmaceutical, aerospace etc.</li> </ol>	<p>On completion of the course, students will be able to</p> <ol style="list-style-type: none"> <li>1. Students will demonstrate knowledge of data analytics.</li> <li>2. Students will demonstrate the ability of think critically in making decisions based on data and deep analytics.</li> <li>3. Students will demonstrate the ability to use technical skills in predicative and prescriptive modeling to support business decision-making.</li> <li>4. Students will demonstrate the ability to translate data into clear, actionable insights</li> </ol>

### UNIT - I

Business analytics: Overview of Business analytics, Scope of Business analytics, Business Analytics Process, Relationship of Business Analytics Process and organisation, competitive advantages of Business Analytics. Statistical Tools: Statistical Notation, Descriptive Statistical methods, Review of probability distribution and data modelling, sampling and estimation methods overview.

### UNIT - II

Trendiness and Regression Analysis: Modelling Relationships and Trends in Data, simple Linear Regression. Important Resources, Business

Analytics Personnel, Data and models for Business analytics, problem solving, Visualizing and Exploring Data, Business Analytics Technology.

### **UNIT – III**

Organization Structures of Business analytics, Team management, Management Issues, Designing Information Policy, Outsourcing, Ensuring Data Quality, Measuring contribution of Business analytics, Managing Changes. Descriptive Analytics, predictive analytics, predicative Modelling, Predictive analytics analysis, Data Mining, Data Mining Methodologies, Prescriptive analytics and its step in the business analytics Process, Prescriptive Modelling, nonlinear Optimization

### **UNIT – IV**

Forecasting Techniques: Qualitative and Judgmental Forecasting, Statistical Forecasting Models, Forecasting Models for Stationary Time Series, Forecasting Models for Time Series with a Linear Trend, Forecasting Time Series with Seasonality, Regression Forecasting with Casual Variables, Selecting Appropriate Forecasting Models. Monte Carlo Simulation and Risk Analysis: Monte Carle Simulation Using Analytic Solver Platform, New-Product Development Model, Newsvendor Model, Overbooking Model, Cash Budget Model.

### **UNIT – V**

Decision Analysis: Formulating Decision Problems, Decision Strategies with the without Outcome Probabilities, Decision Trees, The Value of Information, Utility and Decision Making.

### **UNIT – VI**

Recent Trends in: Embedded and collaborative business intelligence, Visual data recovery, Data Storytelling and Data journalism.

### **Learning Resources:**

1. Business analytics Principles, Concepts, and Applications by Marc J. Schniederjans, Dara G. Schniederjans, Christopher M. Starkey, Pearson FT Press.
2. Business Analytics by James Evans, persons Education.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEAPRTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

## Industrial Safety

Open Elective

### SYLLABUS FOR M.E. - II SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24OE220XX</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

#### UNIT – I

Industrial safety: Accident, causes, types, results and control, mechanical and electrical hazards, types, causes and preventive steps/procedure, describe salient points of factories act 1948 for health and safety, wash rooms, drinking water layouts, light, cleanliness, fire, guarding, pressure vessels, etc, Safety color codes. Fire prevention and firefighting, equipment and methods.

#### UNIT - II

Fundamentals of maintenance engineering: Definition and aim of maintenance engineering, Primary and secondary functions and responsibility of maintenance department, Types of maintenance, Types and applications of tools used for maintenance, Maintenance cost & its relation with replacement economy, Service life of equipment. Model Curriculum of Engineering & Technology PG Courses [Volume -II] 295

#### UNIT - III

Wear and Corrosion and their prevention: Wear- types, causes, effects, wear reduction methods, lubricants-types and applications, Lubrication methods, general sketch, working and applications, i. Screw down grease cup, ii. Pressure grease gun, iii. Splash lubrication, iv. Gravity lubrication, v. Wick feed lubrication vi. Side feed lubrication, vii. Ring lubrication, Definition, principle and factors affecting the corrosion. Types of corrosion, corrosion prevention methods.

#### UNIT - IV

Fault tracing: Fault tracing-concept and importance, decision treeconcept, need and applications, sequence of fault finding activities, show as decision tree, draw decision tree for problems in machine tools, hydraulic, pneumatic,automotive, thermal and electrical equipment's like, I. Any one machine tool, ii. Pump iii. Air compressor, iv. Internal combustion engine,

v. Boiler, vi. Electrical motors, Types of faults in machine tools and their general causes.

## UNIT - V

Periodic and preventive maintenance: Periodic inspection-concept and need, degreasing, cleaning and repairing schemes, overhauling of mechanical components, overhauling of electrical motor, common troubles and remedies of electric motor, repair complexities and its use, definition, need, steps and advantages of preventive maintenance. Steps/procedure for periodic and preventive maintenance of: I. Machine tools, ii. Pumps, iii. Air compressors, iv. Diesel generating (DG) sets, Program and schedule of preventive maintenance of mechanical and electrical equipment, advantages of preventive maintenance. Repair cycle concept and importance

### Learning Resources:

1. Maintenance Engineering Handbook, Higgins & Morrow, Da Information Services.
2. Maintenance Engineering, H. P. Garg, S. Chand and Company.
3. Pump-hydraulic Compressors, Audels, McGraw Hill Publication.
4. Foundation Engineering Handbook, Winterkorn, Hans, Chapman & Hall London.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF MECHANICAL ENGINEERING

## Operations Research

Open Elective

### SYLLABUS FOR M.E. II SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24OE230XX</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
The objective of this course is to: understand Linear & non-linear programming, transportation modelling, CPM & PERT for project scheduling and control, replacement, game theory and sequencing	On completion of the course, the student will be able to: 1. understand simplex, dual simplex, Sensitivity and transportation and their applications for shop floor problems. 2. understand the importance of Sensitivity analysis and various advanced LPP techniques 3. apply the techniques like CPM and PERT for project management. 4. apply various replacement techniques to find optimum replacement time period for equipment. 5. identify the best strategy to win the game and optimum sequence for minimum elapsed time.

### UNIT-I: OPERATIONS RESEARCH-AN OVERVIEW

Meaning and Origin of Operations research, Introduction to Linear programming problems (LPP) -Formulation of LPP-Solution to LPP by Graphical method and simplex method.

### UNIT-II: ADVANCED TOPICS IN LINEAR PROGRAMMING

Dual simplex method, special cases in LPP, Duality in LPP, Differences between primal and dual, shadow prices, sensitivity analysis. Non linear programming Khun Tucker conditions.

### UNIT-III

**Transportation Model:** Definition of the transportation model-matrix of Transportation model-Formulation and solution of transportation models-Methods for calculating Initial basic feasible solution, optimal solution by Stepping stone method and MODI method.



**Assignment Problem:** Hungarian method of assignment problem, maximization in assignment problem, unbalanced problem, problems with restrictions, travelling salesman problems.

#### **UNIT-IV: PROJECT SCHEDULING**

Introduction to network analysis, Rules to draw network diagram, Fulkerson rule for numbering events, Critical path method, Summarisation of CPM calculations. PERT, Estimation of probability and its corresponding duration in PERT, Crashing of project and finding of optimal project duration in crashing.

#### **UNIT-V**

**Replacement models:** Introduction, replacement of items that deteriorate ignoring change in money value, replacement of items that deteriorate considering change in money value with time, replacement of items that fail suddenly – individual replacement policy, group replacement policy.

**Game theory:** Introduction, 2 person zero sum games, maximin– minimax principle, principle of dominance, solution for mixed strategy problems graphical method for  $2 \times n$  and  $m \times 2$  games

**Sequencing models:** introduction, general assumptions, processing to jobs through 2 machines, processing 'n' jobs through m machines processing 2 jobs through m machines.

#### **Learning Resources:**

1. S. D.Sharma, "Operations Research", 10<sup>th</sup> edition, Newage India Pvt Ltd, New Delhi
2. Hamady.A.Taha An Introduction to Operations Research, "8<sup>th</sup> edition, TMH
3. Prem Kumar Gupta and Dr. DS Hira, "Operations Research ", S.Chand & Company Pvt. Ltd., 2014.
4. R. Paneerselvam, "Operations Research", PHI Learning Pvt Ltd., 2009.
5. NVS Raju, "Optimization methods for Engineers ", PHI Learning Pvt. Ltd. ., 2014
6. Col D.S. Cheema, "Operations Research", University science press, 2<sup>nd</sup> edition, India

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEAPRTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

## **Cost Management of Engineering Projects**

Open Elective

SYLLABUS FOR M.E. - II SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P240E240XX</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

Introduction and Overview of the Strategic Cost Management Process  
Cost concepts in decision-making; Relevant cost, Differential cost, Incremental cost and Opportunity cost. Objectives of a Costing System; Inventory valuation; Creation of a Database for operational control; Provision of data for Decision-Making.

Project: meaning, Different types, why to manage, cost overruns centres, various stages of project execution: conception to commissioning. Project execution as conglomeration of technical and nontechnical activities. Detailed Engineering activities. Pre project execution main clearances and documents Project team: Role of each member. Importance Project site: Data required with significance. Project contracts. Types and contents. Project execution Project cost control. Bar charts and Network diagram. Project commissioning: mechanical and process

Cost Behavior and Profit Planning Marginal Costing; Distinction between Marginal Costing and Absorption Costing; Break-even Analysis, Cost-Volume-Profit Analysis. Various decision-making problems. Standard Costing and Variance Analysis. Pricing strategies: Pareto Analysis. Target costing, Life Cycle Costing. Costing of service sector. Just-in-time approach, Material Requirement Planning, Enterprise Resource Planning, Total Quality Management and Theory of constraints. Activity-Based Cost Management, Bench Marking; Balanced Score Card and Value-Chain Analysis. Budgetary Control; Flexible Budgets; Performance budgets; Zero-based budgets. Measurement of Divisional profitability pricing decisions including transfer pricing.

Quantitative techniques for cost management, Linear Programming, PERT/CPM, Transportation problems, Assignment problems, Simulation, Learning Curve Theory.

**Learning Resources:**

1. Cost Accounting A Managerial Emphasis, Prentice Hall of India, New Delhi
2. Charles T. Horngren and George Foster, Advanced Management Accounting
3. Robert S Kaplan Anthony A. Alkinson, Management & Cost Accounting
4. Ashish K. Bhattacharya, Principles & Practices of Cost Accounting A. H. Wheeler publisher
5. N.D. Vohra, Quantitative Techniques in Management, Tata McGraw Hill Book Co. Ltd.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |  |                                    |   |   |
|--------------------------|---|--|------------------------------------|---|---|
| 1. No. of Internal Tests | : | <div style="border: 1px solid black; padding: 2px 10px;">2</div> | Max. Marks for each Internal Tests | : | <div style="border: 1px solid black; padding: 2px 10px;">30</div> |
| 2. No. of Assignments    | : | <div style="border: 1px solid black; padding: 2px 10px;">3</div> | Max. Marks for each Assignment     | : | <div style="border: 1px solid black; padding: 2px 10px;">5</div>  |
| 3. No. of Quizzes        | : | <div style="border: 1px solid black; padding: 2px 10px;">3</div> | Max. Marks for each Quiz Test      | : | <div style="border: 1px solid black; padding: 2px 10px;">5</div>  |

Duration of Internal Test: 90 Minutes

## VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

## DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

**Composite Materials**

Open Elective

## SYLLABUS FOR M.E. - II SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24OE250XX</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

**UNIT-I**

**INTRODUCTION:** Definition – Classification and characteristics of Composite materials. Advantages and application of composites. Functional requirements of reinforcement and matrix. Effect of reinforcement (size, shape, distribution, volume fraction) on overall composite performance.

**UNIT – II**

**REINFORCEMENTS:** Preparation-layup, curing, properties and applications of glass fibers, carbon fibers, Kevlar fibers and Boron fibers. Properties and applications of whiskers, particle reinforcements. Mechanical Behavior of composites: Rule of mixtures, Inverse rule of mixtures. Isostrain and Isostress conditions.

**UNIT – III**

**Manufacturing of Metal Matrix Composites:** Casting – Solid State diffusion technique, Cladding – Hot isostatic pressing. Properties and applications. **Manufacturing of Ceramic Matrix Composites:** Liquid Metal Infiltration – Liquid phase sintering. **Manufacturing of Carbon – Carbon composites:** Knitting, Braiding, Weaving. Properties and applications.

**UNIT-IV**

**Manufacturing of Polymer Matrix Composites:** Preparation of Moulding compounds and prepregs – hand layup method – Autoclave method – Filament winding method – Compression moulding – Reaction injection moulding. Properties and applications.

**UNIT – V**

**Strength:** Laminar Failure Criteria-strength ratio, maximum stress criteria, maximum strain criteria, interacting failure criteria, hygrothermal failure. Laminate first ply failure-insight strength; Laminate strength-ply discount

truncated maximum strain criterion; strength design using caplet plots; stress concentrations.

### **Learning Resources:**

1. Material Science and Technology – Vol 13 – Composites by R.W.Cahn – VCH, West Germany.
2. Materials Science and Engineering, An introduction. WD Callister, Jr., Adapted by R. Balasubramaniam, John Wiley & Sons, NY, Indian edition, 2007.
3. Hand Book of Composite Materials-ed-Lubin.
4. Composite Materials – K.K.Chawla.
5. Composite Materials Science and Applications – Deborah D.L. Chung.
6. Composite Materials Design and Applications – Danial Gay, Suong V. Hoa, and Stephen W. Tasi.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)  
Accredited by NAAC with 'A++' Grade  
IBRAHIMBAGH, HYDERABAD – 500 031

DEAPRTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

## Waste to Energy

Open Elective

### SYLLABUS FOR M.E. ECE (ES&VLSID) - II SEMESTER

L:T:P(Hrs./week): 3:0:0	SEE Marks : 60	Course Code: <b>P24OE260XX</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

#### UNIT-I

Introduction to Energy from Waste: Classification of waste as fuel – Agro based, Forest residue, Industrial waste - MSW – Conversion devices – Incinerators, gasifiers, digestors

#### UNIT - II

Biomass Pyrolysis: Pyrolysis – Types, slow fast – Manufacture of charcoal – Methods - Yields and application – Manufacture of pyrolytic oils and gases, yields and applications.

#### UNIT – III

Biomass Gasification: Gasifiers – Fixed bed system – Downdraft and updraft gasifiers – Fluidized bed gasifiers – Design, construction and operation – Gasifier burner arrangement for Model Curriculum of Engineering & Technology PG Courses [Volume -II] 299 thermal heating – Gasifier engine arrangement and electrical power – Equilibrium and kinetic consideration in gasifier operation.

#### UNIT - IV

Biomass Combustion: Biomass stoves – Improved chullahs, types, some exotic designs, Fixed bed combustors, Types, inclined grate combustors, Fluidized bed combustors, Design, construction and operation - Operation of all the above biomass combustors.

#### UNIT – V

Biogas: Properties of biogas (Calorific value and composition) - Biogas plant technology and status - Bio energy system - Design and constructional features - Biomass resources and their classification - Biomass conversion processes - Thermo chemical conversion - Direct combustion - biomass gasification - pyrolysis and liquefaction - biochemical conversion - anaerobic digestion - Types of biogas Plants –

Applications - Alcohol production from biomass - Bio diesel production - Urban waste to energy conversion - Biomass energy programme in India.

**Learning Resources:**

1. Non Conventional Energy, Desai, Ashok V., Wiley Eastern Ltd., 1990.
2. Biogas Technology - A Practical Hand Book - Khandelwal, K. C. and Mahdi, S. S., Vol. I & II, Tata McGraw Hill Publishing Co. Ltd., 1983.
3. Food, Feed and Fuel from Biomass, Challal, D. S., IBH Publishing Co. Pvt. Ltd., 1991.
4. Biomass Conversion and Technology, C. Y. WereKo-Brobby and E. B. Hagan, John Wiley & Sons, 1996.

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |   |                                |                                    |   |                                 |
|--------------------------|---|--------------------------------|------------------------------------|---|---------------------------------|
| 1. No. of Internal Tests | : | <input type="text" value="2"/> | Max. Marks for each Internal Tests | : | <input type="text" value="30"/> |
| 2. No. of Assignments    | : | <input type="text" value="3"/> | Max. Marks for each Assignment     | : | <input type="text" value="5"/>  |
| 3. No. of Quizzes        | : | <input type="text" value="3"/> | Max. Marks for each Quiz Test      | : | <input type="text" value="5"/>  |

Duration of Internal Test: 90 Minutes

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS)

Accredited by NAAC with 'A++' Grade

IBRAHIMBAGH, HYDERABAD – 500 031

DEPARTMENT OF INFORMATION TECHNOLOGY

**Fundamentals of Python Programming**

(Open Elective) SYLLABUS FOR M.E. / M.Tech. II – SEMESTER

(Common to all Branches)

L:T:P(Hrs./week): 2:0:0	SEE Marks : 60	Course Code: <b>P24OE270XX</b>
Credits : 3	CIE Marks : 40	Duration of SEE : 3 Hours

COURSE OBJECTIVES	COURSE OUTCOMES
2. Acquire problem solving skills 3. Write programs using Python language and use Python Libraries	On completion of the course, students will be able to 1. Develop Python programs with conditional statements and loops. 2. Write programs using functions, strings and lists. 3. Construct Python data structures programs using tuples, dictionaries and set. 4. Write programs using Files and Class Concept . 5. Try simple example using Python libraries NumPy, SciPy and Matplotlib

**UNIT-I:****Basics of Python Programming:** Features of Python, variables and identifiers, operators and expressions.**Decision control Statements:** Selection/Conditional branching statements, basic loop structures/iterative Statements, nested loops, break, continue, and pass Statements.**Functions and Modules:** function definition, function call, more on defining functions, recursive functions, modules.**UNIT-II:****Data Structures: Strings:** Introduction, built-in string methods and functions, slice operation, String Module. Regular Expressions.**Lists:** Introduction, nested list, cloning lists, basic list operations, list methods. Functional programming-filter(),map(),reduce() function.



**UNIT –III:**

**Tuples:** Introduction, basic tuple operations, tuple assignment, tuples for returning multiple values, nested tuples, tuple methods and functions.

**Set:** Introduction, Set operations.

**Dictionaries:** Basic operations, sorting items, looping over dictionary, nested dictionaries, built-in dictionary functions.

**UNIT-IV:**

**Files and Exceptions:** reading and writing files, pickling, handling exceptions. Built-in and user-defined exceptions.

**OOPS Concepts:** Introduction, classes and object, class method and self argument, theinit() method, class variables and object variables, public and private data members, Inheritance, Operator Overloading.

**UNIT-V:**

**Python Libraries: NumPy** – Introduction, Arrays – creation, operations, **SciPy**– Introduction, linalg, special, **Matplotlib** – Introduction, types of Plots, using pyplot.

**Learning Resources:**

1. Reema Thareja, "Python programming using problem solving approach ", Oxford universitypress.
2. Allen Downey, " Think Python: How to Think Like a Computer Scientist", O'Reilly publications, 2<sup>nd</sup> Edition.
3. Mark Lutz, "Learning Python", O'Reilly Publications.
4. Wesley.J.Chun, "Core Python Programming", Prentice Hall, 2nd Edition.
5. <http://www.python.org>

The break-up of CIE : Internal Tests + Assignments + Quizzes

- |                          |     |                                    |      |
|--------------------------|-----|------------------------------------|------|
| 1. No. of Internal Tests | : 2 | Max. Marks for each Internal Tests | : 30 |
| 2. No. of Assignments    | : 3 | Max. Marks for each Assignment     | : 5  |
| 3. No. of Quizzes        | : 3 | Max. Marks for each Quiz Test      | : 5  |

Duration of Internal Test: 90 Minutes